











LM3532

## SNVS653E - JULY 2011 - REVISED AUGUST 2015

# LM3532 High-Efficiency White LED Driver With Programmable Ambient Light Sensing Capability and I<sup>2</sup>C-Compatible Interface

#### **Features**

- Drives up to 3 Parallel High-Voltage LED Strings at 40 V Each With up to 90% Efficiency
- 0.4% Typical Current Matching Between Strings
- 256 Level Logarithmic and Linear Brightness Control With 14-Bit Equivalent Dimming
- I<sup>2</sup>C-Compatible Interface
- Direct Read Back of Ambient Light Sensor Via 8-bit ADC
- Programmable Dual Ambient Light Sensor Inputs With Internal Sensor Gain Selection
- Dual External PWM Inputs for LED Brightness Adjustment
- Independent Current String Brightness Control
- Programmable LED Current Ramp Rates
- 40-V Overvoltage Protection
- 1-A Typical Current Limit

## **Applications**

- Power Source for White LED Backlit LCD Displays
- Programmable Keypad Backlight

## 3 Description

The LM3532 is a 500-kHz fixed asynchronous boost converter which provides the power for 3 high-voltage, low-side current sinks. The device is programmable over an I<sup>2</sup>C-compatible interface and has independent current control for all three channels. The adaptive current regulation method allows for different LED currents in each current sink thus allowing for a wide variety of backlight and keypad applications.

The main features of the LM3532 include dual ambient light sensor inputs each with 32 internal voltage setting resistors, 8-bit logarithmic and linear brightness control, dual external PWM brightness control inputs, and up to 1000:1 dimming ratio with programmable fade in and fade out settings.

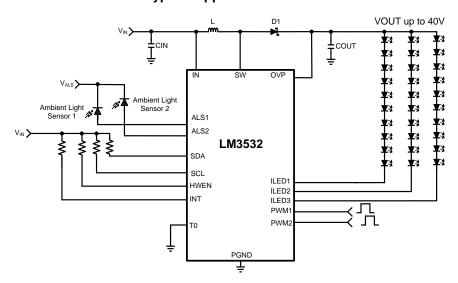
The LM3532 is available in a 16-pin, 0.4-mm pitch thin DSBGA package. The device operates over a 2.7-V to 5.5-V input voltage range and the -40°C to +85°C temperature range.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (MAX)
LM3532	DSBGA (16)	1.87 mm x 1.77 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## Typical Application Circuit





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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

## Changes from Revision D (June 2013) to Revision E

Page

Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description,
 Device Functional Modes, Application and Implementation, Power Supply Recommendations, Layout, Device and
 Documentation Support, and Mechanical, Packaging, and Orderable Information sections

### Changes from Revision C (March 2013) to Revision D

Page

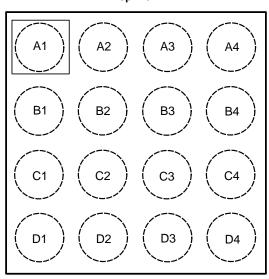
## Changes from Revision B (July 2012) to Revision C

Page



## 5 Pin Configuration and Functions

## YFQ Package 16-Pin DSBGA Top View



### **Pin Functions**

	PIN	TYPE	DECORIDATION			
NO.	NAME	ITPE	DESCRIPTION			
A1	OVP	IN	Output voltage sense connection for overvoltage sensing. Connect OVP to the positive terminal of the output capacitor.			
A2	ILED3	IN	put terminal to high voltage current sink 3 (40 V maximum). The boost converter regulates the inimum of ILED1, ILED2, or ILED3 to 0.4V.			
A3	ILED2	IN	Input terminal to high voltage current sink 2 (40 V maximum). The boost converter regulates the minimum of ILED1, ILED2, or ILED3 to 0.4V.			
A4	ILED1	IN	put terminal to high voltage current sink 1 (40 V maximum). The boost converter regulates the inimum of ILED1, ILED2, or ILED3 to 0.4V.			
B1	ALS1	IN	Ambient light sensor input 1.			
B2	ALS2	IN	Ambient light sensor input 2.			
B3	HWEN	IN	Active high hardware enable. Pull this pin high to enable the LM3532. HWEN is a high impedance input.			
B4	IN	IN	Input voltage connection. Bypass IN to GND with a minimum 2.2-μF ceramic capacitor.			
C1	PWM2	IN	External PWM brightness control Input 2.			
C2	PWM1	IN	External PWM brightness Ccontrol Input 1.			
C3	INT	OUT	Programmable Interrupt pin. INT is an open-drain output that pulls low when the ALS changes zones.			
C4	GND	GND	Ground			
D1	SDA	I/O	Serial data connection for I <sup>2</sup> C-compatible interface			
D2	SCL	IN	Serial clock connection for I <sup>2</sup> C-compatible interface			
D3	TO	IN	Unused test input. This pin must be tied externally to GND for proper operation.			
D4	SW	IN	Drain connection for boost converters internal NFET			



## 6 Specifications

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1) (2) (3)

	MIN MAX	UNIT
V <sub>IN</sub> to GND		V
V <sub>SW</sub> , V <sub>OVP</sub> , V <sub>ILED1</sub> , V <sub>ILED2</sub> , V <sub>ILED3</sub> to GND		V
$\begin{array}{c} V_{SCL},V_{SDA},V_{ALS1},V_{ALS2},V_{PWM1},V_{PWM2},V_{INT},\\ V_{HWEN},V_{T0}\text{ to GND} \end{array}$		V
Continuous power dissipation	Internally Limited	
Junction temperature , T <sub>J-MAX</sub>	150	°C
Maximum lead temperature (soldering, 10s) <sup>(4)</sup>	300	°C
Storage temperature, T <sub>stg</sub>	-65 150	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/ Distributors for availability and specifications
- (3) All voltages are with respect to the potential at the GND pin.
- (4) For detailed soldering specifications and information, refer to Application Note AN-1112: DSBGA Wafer Level Chip Scale Package (SNVA009).

## 6.2 ESD Ratings

			VALUE	UNIT
V	Electrostatic	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2000	<b>V</b>
V <sub>(ESD)</sub>	discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±5000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) (1)(2)

	MIN	NOM MAX	UNIT
V <sub>IN</sub> to GND	2.7	5.5	V
V <sub>SW</sub> , V <sub>OVP</sub> , V <sub>ILED1</sub> , V <sub>ILED2</sub> , V <sub>ILED3</sub> to GND	0	40	V
Junction temperature, T <sub>J</sub> <sup>(3)(4)</sup>	-40	125	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to the potential at the GND pin.
- (3) Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T<sub>J</sub>= 140°C (typical) and disengages at T<sub>J</sub>= 125°C (typical).
- (4) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T<sub>A-MAX</sub>) is dependent on the maximum operating junction temperature (T<sub>J-MAX-OP</sub> = 125°C), the maximum power dissipation of the device in the application (P<sub>D-MAX</sub>), and the junction-to ambient thermal resistance of the part/package in the application (R<sub>θJA</sub>), as given by the following equation: T<sub>A-MAX</sub> = T<sub>J-MAX-OP</sub> (R<sub>θJA</sub> × P<sub>D-MAX</sub>).

#### 6.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	YFQ (DSBGA)	UNIT
		16 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	61.3	°C/W

 For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



### 6.5 Electrical Characteristics

Minimum and maximum limits apply over the full operating ambient temperature range ( $-40^{\circ}C \le T_A \le +85^{\circ}C$ ), typical limits are for  $T_A = 25^{\circ}C$ , and  $V_{IN} = 3.6$  V, unless otherwise specified. (1)(2)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
L	Output current regulation accuracy	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$ , ControlX full-scale current register = 0xF3, brightness code = 0xFF		20.2		mA	
I <sub>LED(1/2/3)</sub>	(ILED1, ILED2 or ILED3)	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$ , ControlX full-scale current register = 0xF3, brightness code = 0xFF	18.68		21.8	mA	
I <sub>MATCH</sub> (3) (4)	II ED2 to II ED2 ourrent metabling	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{I}_{\text{FULL\_SCALE}} = 20.2 \text{ mA}$ Brightness code = $0 \text{xFF}$		0.3%			
'MATCH\'''	ILED2 to ILED3 current matching	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{I}_{\text{FULL\_SCALE}} = 20.2 \text{ mA}$ Brightness code = $0 \text{xFF}$	-2%		2%		
$V_{REG\_CS}$	Regulated current sink headroom voltage			400		mV	
$V_{HR}$	Current sink minimum headroom	I <sub>LED</sub> = 95% of nominal and 20.2 mA		200		mV	
	voltage	I <sub>LED</sub> = 95% of nominal and 20.2 mA			240		
R <sub>DSON</sub>	NMOS switch on resistance	I <sub>SW</sub> = 100 mA		0.25		Ω	
	NMOS switch current limit	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$		1000		mA	
I <sub>CL</sub>		$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$	880	1000	1120	mA	
	Output overvoltage protection	ON threshold, 2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V		41			
$V_{OVP}$		ON threshold, $2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$	40		42	V	
		Hysteresis		1			
D <sub>MAX</sub>	Maximum duty cycle			94%			
D <sub>MIN</sub>	Minimum duty cycle			10%			
ΙQ	Quiescent current into IN, device not switching	ILED1 = ILED2 = ILED3 = 20.2 mA, feedback disabled		490		μΑ	
I <sub>Q_SW</sub>	Switching supply current	I <sub>LED1</sub> = I <sub>LED2</sub> = I <sub>LED3</sub> = 20.2 mA, V <sub>OUT</sub> = 32 V		1.35		mA	
		2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V, HWEN = GND		1			
I <sub>SHDN</sub> Shutdown current		$2.7 \text{ V} \le V_{IN} \le 5.5 \text{ V}, \text{HWEN} = \text{GND} \\ -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	2		μΑ		
I <sub>LED_MIN</sub>	Minimum LED Current in ILED1, ILED2 or ILED3	Full-scale current =20.2 mA Brightness code = 0x01, Mapping = Exponential		9.5		μΑ	
	Thermal Shutdown			140		°C	
T <sub>SD</sub>	Hysteresis			15		30	

<sup>(1)</sup> All voltages are with respect to the potential at the GND pin.

<sup>(2)</sup> Minimum and Maximum limits are verified by design, test, or statistical analysis. Typical numbers are not verified, but do represent the most likely norm.

<sup>(3)</sup> All current sinks for the matching spec are assigned to the same control bank.

<sup>(4)</sup> LED current sink matching between ILED2 and ILED3 is given by taking the difference between either (ILED2 or ILED3) and the average current between the two, and dividing by the average current between the two (ILED2/3 – ILED(AVE))/ILED(AVE). This simplifies to (ILED2 – ILED3)/(ILED2 + ILED3). In this test, both ILED2 and ILED3 are assigned to Bank A.



## **Electrical Characteristics (continued)**

Minimum and maximum limits apply over the full operating ambient temperature range ( $-40^{\circ}C \le T_A \le +85^{\circ}C$ ), typical limits are for  $T_A = 25^{\circ}C$ , and  $V_{IN} = 3.6$  V, unless otherwise specified. (1)(2)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
LOGIC INP	UTS/OUTPUTS (PWM1, PWM2, HWE	EN, SCL, SDA, INT)				
V <sub>IL</sub>	Input logic low	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V	0		0.4	V
V <sub>IH</sub>	Input logic high	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V	1.2		$V_{IN}$	V
V <sub>OL</sub>	Output logic low (SCL, INT)	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}, \text{I}_{\text{LOAD}} = 3 \text{ mA}$			0.4	V
R <sub>PWM</sub>	PWM input internal pulldown resistance (PWM1, PWM2)			100		kΩ
AMBIENT I	LIGHT SENSOR INPUTS (ALS1, ALS	2)	•		·	
R <sub>ALS1</sub> ,	ALS pin internal pulldown resistors	ALS1, ALS2 Resistor Select Register = 0x0F, 2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V		2.44		
R <sub>ALS2</sub>		ALS1, ALS2 Resistor Select Register = 0x0F, 2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V	2.29		2.59	kΩ
V	Ambient light sensor reference	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V		2		
V <sub>ALS_REF</sub>	voltage	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V	1.94		2.06	V
V	ALS input offset voltage	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V		2.5		\/
V <sub>OS</sub>	(Code 0-to-1 transition – V <sub>LSB</sub> )	2.7 V ≤ V <sub>IN</sub> ≤ 5.5 V	0.8		4.2	mV
t <sub>CONV</sub>	Conversion time				154	μs
LSB	ADC resolution	2.7V ≤ V <sub>IN</sub> ≤ 5.5V		7.84		mV

## 6.6 I<sup>2</sup>C-Compatible Timing Specifications (SCL, SDA)

See<sup>(1)</sup>

		MIN	NOM MAX	UNIT
t <sub>1</sub>	SCL (clock period)	2.5		μs
t <sub>2</sub>	Data In setup time to SCL high	100		ns
t <sub>3</sub>	Data out stable after SCL low	0		ns
t4	SDA low setup time to SCL low (start)	100		ns
t <sub>5</sub>	SDA high hold time after SCL high (stop)	100		ns

<sup>(1)</sup> SCL and SDA must be glitch-free in order for proper brightness control to be realized.

## 6.7 Switching Characteristics

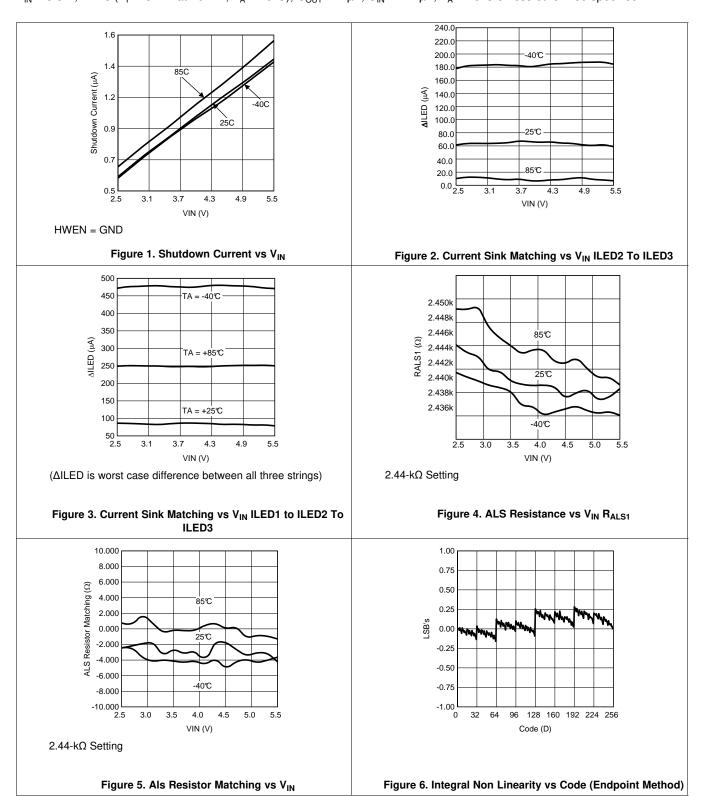
over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
		$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$		500		
$f_{\sf SW}$	Switching frequency	$2.7 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$ $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$	450		550	kHz



## 6.8 Typical Characteristics

 $V_{IN}=3.6~V,~LEDs~(V_F=3.2~V~at~20~mA,~T_A=25^{\circ}C),~C_{OUT}=1~\mu F,~C_{IN}=2.2~\mu F,~T_A=25^{\circ}C~unless~otherwise~specified.$ 



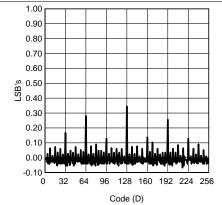
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## **Typical Characteristics (continued)**

 $V_{\text{IN}} = 3.6 \text{ V, LEDs (V}_{\text{F}} = 3.2 \text{ V at 20 mA, T}_{\text{A}} = 25^{\circ}\text{C), C}_{\text{OUT}} = 1 \text{ } \mu\text{F, C}_{\text{IN}} = 2.2 \text{ } \mu\text{F, T}_{\text{A}} = 25^{\circ}\text{C unless otherwise specified.}$ 



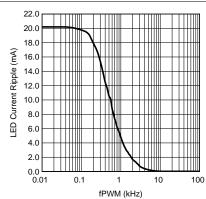


Figure 7. Differential Non Linearity vs Code

Figure 8. Peak-to-Peak LED Current Ripple vs  $F_{\text{PWM}}$ 

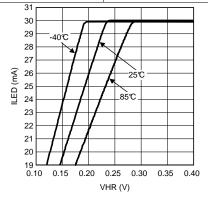


Figure 9. LED Current vs Headroom Voltage

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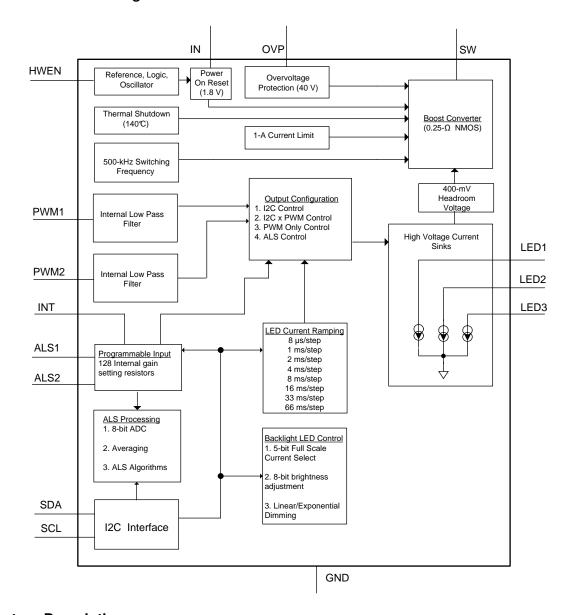


## 7 Detailed Description

#### 7.1 Overview

The LM3532 backlight driver consists of three 30-mA current sinks, a dual input ambient light sensor interface, and a dual input PWM control. The LED current can be controlled via either the I<sup>2</sup>C bus, the PWM input, the ambient light sensor interface, or a combination of each. The programmable options via I<sup>2</sup>C allow for the three current sinks to be controlled independently or be controlled by a single source.

## 7.2 Functional Block Diagram



## 7.3 Feature Description

## 7.3.1 40-V Boost Converter

The LM3532 contains a 40-V maximum output voltage, asynchronous boost converter with an integrated 250-m $\Omega$  switch, and three low-side current sinks. Each low-side current sink is independently programmable from 0 to 30 mA.

## Feature Description (continued)

### 7.3.2 Hardware Enable Input

HWEN is the LM3532 device's global hardware enable input. This pin must be driven high to enable the device. HWEN is a high-impedance input so cannot be left floating. Typically HWEN would be connected through a pullup resistor to the logic supply voltage or driven high from a microcontroller. Driving HWEN low places the LM3532 into a low-current shutdown state and force all the internal registers to their power-on reset (POR) states.

#### 7.3.3 Feedback Enable

Each current sink can be set for feedback enable or feedback disable. When feedback is enabled, the boost converter maintains at least 400 mV across each active current sink. This causes the boost output voltage  $(V_{OUT})$  to raise up or down depending on how many LEDs are placed in series in the highest voltage string. This ensures there is a minimum headroom voltage across each current sink. The potential drawback is that for large differentials in LED counts between strings, the LED voltage can be drastically different causing the excess voltage in the lower LED string to be dropped across its current sink. In situations where there are other voltage sources available, or where the LED count is low enough to use  $V_{IN}$  as the power source, the feedback can be disabled on the specific current sink. This allows for the current sink to be active, but eliminates its control over the boost output voltage (see Figure 10). In this situation care must be taken to ensure there is always at least 400 mV of headroom voltage across each active current sink to avoid the current from going out of regulation. Control over the feedback enable/disable is programmable via the Feedback Enable Register (see Table 13).

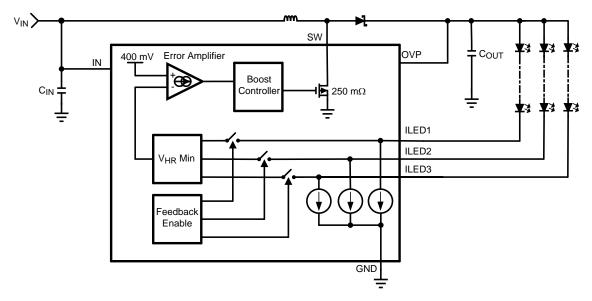


Figure 10. LM3532 Feedback Enable/Disable

## 7.3.4 LM3532 Current Sink Configuration

Control of the LM3532 device's three current sinks is done by configuring the three internal control banks (Control A, Control B, and Control C) (see Figure 11). Any of the current sinks (ILED1, ILED2, or ILED3) can be mapped to any of the three control banks. Configuration of the control banks is done via the Output Configuration register.

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### Feature Description (continued)

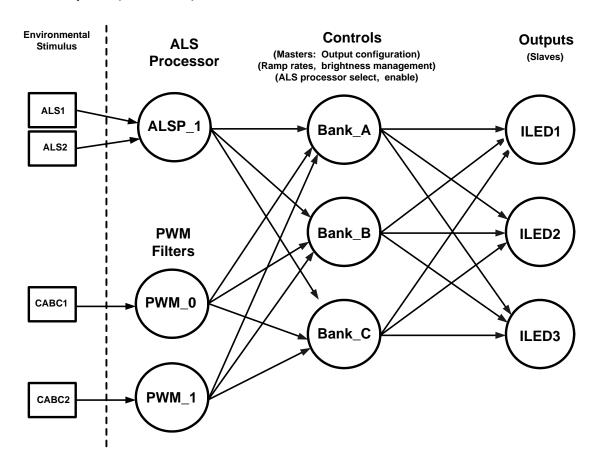


Figure 11. LM3532 Functional Control Diagram

#### 7.3.5 PWM Inputs

The LM3532 provides two PWM inputs (PWM1 and PWM2) which can be mapped to any of the three Control Banks. PWM input mapping is done through the Control A PWM Configuration register, the Control B PWM Configuration register, and the Control C PWM Configuration register.

Both PWM inputs (PWM1 and PWM2) feed into internal level shifters and lowpass filters. This allows the PWM inputs to accept logic level signals and convert them to analog control signals which can control the assigned Control Banks LED current. The internal lowpass filter at each PWM input has a typical corner frequency of 540 Hz with a Q of 0.5. This gives a low end useful PWM frequency of around 2 kHz. Frequencies lower than this cause the LED current to show larger ripple and result in non-linear behavior vs. duty cycle due to the response time of the boost circuit. The upper boundary of the PWM frequency is greater than 100 kHz. Frequencies above 200 kHz begin to show non linear behavior due to propagation delays through the PWM input circuitry.

## 7.3.6 Full-Scale LED Current

There are 32 programmable full-scale current settings for each of the three control banks (Control A, Control B, and Control C). Each control bank has its own independent full-scale current setting (I<sub>LED FULL SCALE</sub>). Full-scale current for the respective Control Bank is set via the Control A Full-Scale Current Register, the Control B Full-Scale Current Register, and the Control C Full-Scale Current Register (see Table 12).

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## **Feature Description (continued)**

### 7.3.7 Interrupt Output

INT is an open drain output that pulls low when the ALS is enabled and when one of the ALS inputs transitions into a new zone. At the same time, the ALS Zone Information register is updated with the current ALS zone, and the software flag (bit 3 of the ALS Zone Information register) is written high. A readback of the Zone Information Register clears the software interrupt flag and reset the INT output to the open drain state. The active pulldown at INT is typically  $125~\Omega$ .

#### 7.3.8 Protection Features

#### 7.3.8.1 Overvoltage Protection

The LM3532 devices's boost converter provides open-load protection, by monitoring the OVP pin. The OVP pin is designed to connect as close as possible to the positive terminal of the output capacitor. In the event of a disconnected load (LED current string with feedback enabled), the output voltage rises in order to try and maintain the correct headroom across the feedback enabled current sinks (see Table 13). Once  $V_{OUT}$  climbs to the OVP threshold ( $V_{OVP}$ ) the boost converter is turned off, and switching stops until  $V_{OUT}$  falls below the OVP hysteresis ( $V_{OVP} - 1$  V). Once the OVP hysteresis is crossed the LM3532 device's boost converter begins switching again. In open load conditions this would result in a pulsed on/off operation.

#### 7.3.8.2 Current Limit

The LM3532 device's peak current limit in the NFET is set at typically 1 A (880 mA, minimum). During the positive portion of the switching cycle, if the NFET's current rises up to the current limit threshold, the NFET turns off for the rest of the switching cycle. At the start of the next switching cycle the NFET turns on again. For loads that cause the LM3532 to hit current limit each switching cycle, the output power can become clamped because the headroom across the feedback enabled current sinks is no longer being regulated when the device is in current limit. See *Maximum Output Power* below for guidelines on how peak current affects the LM3532 device's maximum output power.

### 7.4 Device Functional Modes

## 7.4.1 LED Current Ramping

The LM3532 provides 4 methods to control the rate of rise or fall of the LED current during these events:

- 1. Start-up from 0 to the initial target
- 2. Shutdown
- 3. Ramp up from one brightness level to the next
- 4. Ramp down from one brightness level to the next

See Table 4 and Table 5.

## 7.4.2 Start-up and Shutdown Current Ramping

The start-up and shutdown ramp rates are independently programmable in the Start-up/Shutdown Ramp Rate register (see Table 4). There are 8 different start-up and 8 different shutdown ramp rates. The start-up ramp rates are independently programmable from the shutdown ramp rates, but not independently programmable for each Control Bank. For example, programming a start-up or shutdown ramp rate, programs the same ramp rate for each Control Bank.

## 7.4.3 Run-Time Ramp Rates

Current ramping from one brightness level to the next is programmed via the Run-Time Ramp Rate Register (see Table 5). There are 8 different ramp-up and 8 different ramp-down rates. The ramp-up rate is independently programmable from the ramp-down rate, but not independently programmable for each Control Bank. For example, programming a ramp-up or a ramp-down rate programs the same rate for each Control Bank.



## **Device Functional Modes (continued)**

### 7.4.4 LED Current Mapping Modes

All LED current brightness codes are 8 bits (256 different levels), where each bit represents a percentage of the programmed full-scale current setting for that particular Control Bank. The percentage of the full-scale current is different depending on which mapping mode is selected. The mapping mode can be either exponential or linear. Mapping mode is selected via bit [1] of the Control A, B, or C Brightness Configuration Registers.

### 7.4.5 Exponential Current Mapping Mode

In exponential mapping mode, the backlight code to LED current approximates the following equation:

$$I_{LED} = I_{LED\_FULLSCALE} \times 0.85^{\left[40 - \left(\frac{Code^{+1}}{6.4}\right)\right]} \times D_{PWM}$$

where

- Code is the 8-bit code in the programmed brightness register
- D<sub>PWM</sub> is the duty cycle of the PWM input that is assigned to the particular control bank

Figure 12 shows the typical response of percentage of full-scale current setting vs 8-bit brightness code.

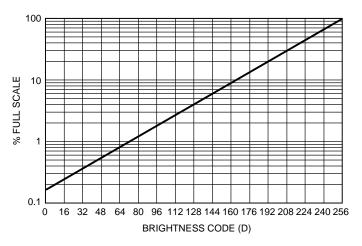


Figure 12. Exponential Mapping Response

## 7.4.6 Linear Current Mapping

In linear mapping mode the backlight code to LED current approximates Equation 2:

$$I_{LED} = I_{LED\_FULLSCALE} \times \frac{1}{255} \times Code \times D_{PWM}$$

where

- · Code is the 8-bit code in the programmed brightness register
- DPWM is the duty cycle of the PWM input that is assigned to the particular control bank.

For the linear mapped mode (Figure 13) shows the typical response of percentage of full-scale current setting vs 8-bit brightness code.

Product Folder Links: LM3532

(2)

## **Device Functional Modes (continued)**

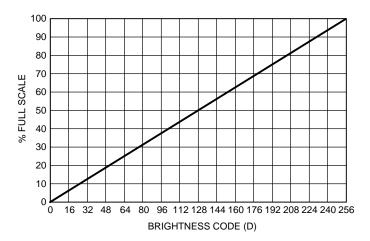


Figure 13. Linear Mapping Response

#### 7.4.7 LED Current Control

Once the full-scale current is set, control of the LM3532 device's LED current can be done via 2 methods:

- 1. I<sup>2</sup>C Current Control
- 2. Ambient Light Sensor Current Control

I<sup>2</sup>C current control allows for the direct control of the LED current by writing directly to the specific brightness register. In ambient light sensor current control the LED current is automatically set by the ambient light sensor interface.

### 7.4.7.1 PC Current Control

I<sup>2</sup>C current control is accomplished by using one of the Zone Target Registers (for the respective Control Bank) as the brightness register. This is done via bits[4:2] of the Control (A, B, or C) Brightness Registers (see Table 9, Table 10, and Table 11). For example, programming bits[4:2] of the Control A Brightness Register with (000) makes the brightness register for Bank A (in I<sup>2</sup>C Current Control) the Control A Zone Target 0 Register.

#### 7.4.7.2 PC Current Control With PWM

I<sup>2</sup>C current control can also incorporate the PWM duty cycle at one of the PWM inputs (PWM1 or PWM2). In this situation the LED current is then a function of both the code in the programmed brightness register and the duty cycle input into the assigned PWM inputs (PWM1 or PWM2).

## 7.4.8 Assigning and Enabling a PWM Input

To make the backlight current a function of the PWM input duty cycle, one of the PWM inputs must first be assigned to a particular Control Bank. This is done via bit [0] of the Control A, B, or C PWM Registers (see Table 6, Table 7, or Table 8). After assigning a PWM input to a Control Bank, the PWM input is then enabled via bits [6:2] of the Control A/B/C PWM Enable Registers. Each enable bit is associated with a specific Zone Target Register in I<sup>2</sup>C Current Control. For example, if Control A Zone Target 0 Register is configured as the brightness register, then to enable PWM for that brightness register, Control A PWM bit [2] would be set to 1.

### 7.4.9 Enabling a Current Sink

Once the brightness register and PWM inputs are configured in I<sup>2</sup>C Current Control, the current sinks assigned to the specific control bank are enabled via the Control Enable Register (see Table 14). Table 1 below shows the possible configurations for Control Bank A in I<sup>2</sup>C Current Control. Table 1 would also apply to Control Bank B and Control Bank C.



## **Device Functional Modes (continued)**

Table 1. I<sup>2</sup>C Current Control and PWM Bit Settings (For Control Bank A)

CURRENT SINK ASSIGNMENT	BRIGHTNESS REGISTER	PWM SELECT	PWM ENABLE	CURRENT SINK ENABLE
Output Configuration Register Bits[1:0] = 00, assigns ILED1 to Control Bank A Bits[3:2] = 00 assigns ILED2 to Control Bank A Bits[5:4] = 00, assigns ILED3 to Control Bank A	Control A Brightness Configuration Register Bits [4:2] 000 selects Control A Zone Target 0 as brightness register 001 selects Control A Zone Target 1 brightness register 010 selects Control A Zone Target 2 brightness register 011 selects Control A Zone Target 3 brightness register 1XX selects Control A Zone Target 4 brightness register	Control A PWM Register Bit[0] 0 selects PWM1 1 selects PWM2	Control A PWM Register Bit[2] is PWM enable when Control A Zone Target 0 is configured as the brightness register Bit[3] is PWM enable when Control A Zone Target 1 is configured as the brightness register Bit[4] is PWM enable when Control A Zone Target 2 is configured as the brightness register Bit[5] is PWM enable when Control A Zone Target 3 is configured as the brightness register Bit[6] is PWM enable when Control A Zone Target 4 is configured as the brightness register	Control Enable Register Bit [0] 0 = Bank A Disabled 1 = Bank A Enabled

## 7.4.10 Ambient Light Sensor Current Control

In Ambient Light Sensor (ALS) current control the LM3532 device's backlight current is automatically set based upon the voltage at the ambient light sensor inputs (ALS1 and/or ALS2). These inputs are designed to connect to the outputs of analog ambient light sensors. Each ALS input has an active input voltage range of 0 to 2 V.

#### 7.4.10.1 ALS Resistors

The LM3532 offers 32 separate programmable internal resistors at the ALS1 and ALS2 inputs. These resistors take the ambient light sensor's output current and convert it into a voltage. The value of the resistor selected is typically chosen such that the ambient light sensors output voltage swing goes from 0 to 2 V across the intended measured ambient light (LUX) range. The ALS resistor values are programmed via the ALS1 and ALS2 Resistor select registers (see Table 15). The code-to-resistor selection (assuming a 2-V full-scale voltage range) is shown in Equation 3:

$$R_{ALS_{-}} = \frac{2V}{54 \ \mu A} \times Code \tag{3}$$

Each higher code in the specific ALS Resistor Select Register increases the allowed ALS sensor current by 54  $\mu$ A ( for a 2-V full-scale). When the ALS is disabled (ALS Configuration Register bit [3] = 0) the ALS inputs are set to a high impedance mode no matter what the ALS resistor selection is. Alternatively, ALS Resistor Select Register Code 00000 sets the specific ALS input to high impedance.

#### 7.4.10.2 Ambient Light Zone Boundaries

The LM3532 provides 5 ambient light brightness zones which are defined by 4 zone boundary registers. The LM3532 has one set of zone boundary registers that is shared globally by all control banks. As the voltage at the ALS input changes in response to the ambient light sensors received light, the ALS voltage transitions through the 5 defined brightness zones. Each brightness zone can be assigned a brightness target via the 5 zone target registers. Each control bank has its own set of zone target registers. Therefore, in response to changes in a Brightness Zone at the ALS input, the LED current can transition to a new brightness level. This allows for backlit LCD displays to reduce the LED Current when the ambient light is dim or increase the LED current when the ambient light increases. Each zone boundary register is 8 bits with a full-scale voltage of 2 V. This gives 2 V/255 = 7.8 mV per bit. Figure 14 describes the ambient light to brightness mapping.

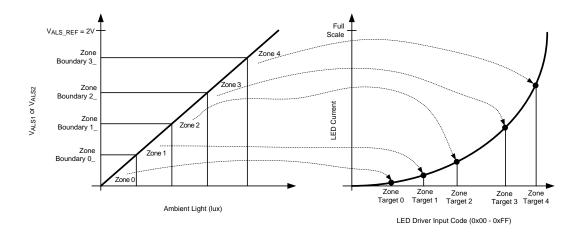


Figure 14. Ambient Light Input to Backlight Mapping

## 7.4.10.3 Ambient Light Zone Hysteresis

For each Zone Boundary there are two Zone Boundary Registers: a Zone Boundary High Register and a Zone Boundary Low Register. The difference between the Zone Boundary High and Zone Boundary Low Register set points (for a specific zone) creates the hysteresis that is required to transition between two adjacent zones. This hysteresis prevents the backlight current from oscillating between zones when the ALS voltage is close to a Zone Boundary Threshold. Figure 15 describes this Zone Boundary Hysteresis. The arrows indicate the direction of the ALS input voltage. The black dots indicate the threshold used when transitioning to a new zone.

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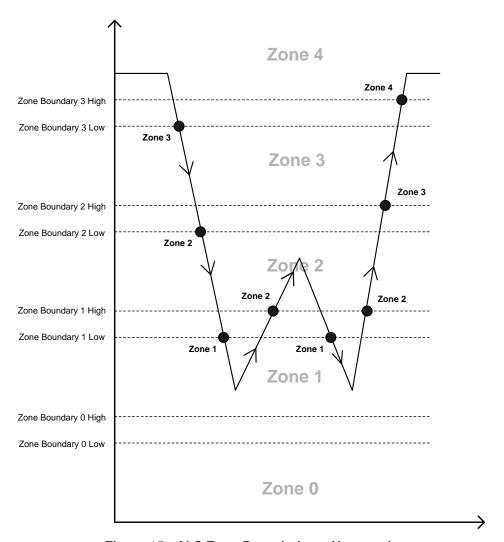


Figure 15. ALS Zone Boundaries + Hysteresis

### 7.4.10.4 PWM Enabled for a Particular Zone

The active PWM input for a specified control bank can be enabled/disabled for each ALS Brightness Zone. This is done via bits[6:2] of the corresponding Control A, B, or C PWM Registers (see Table 6, Table 7, and Table 8). For example, assuming Control Bank A is being used, then to make the PWM input active in Zones 0, 2, and 4, but not active in Zones 1, and 3; bits[6:2] of the Control A PWM Register would be set to (1, 0, 1, 0, 1).

### 7.4.10.5 ALS Operation

Figure 16 shows a functional block diagram of the LM3532's ambient light sensor interface.



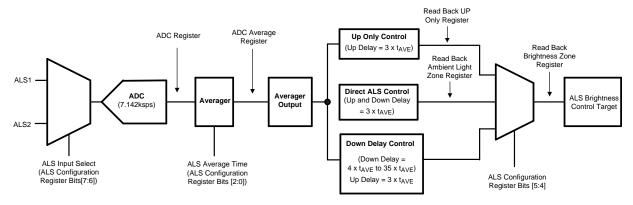


Figure 16. ALS Functional Block Diagram

#### 7.4.10.6 ALS Input Select and ALS ADC Input

The internal 8-bit ADC digitizes the active ambient light sensor inputs (ALS1 or ALS2). The active ALS input is determined by the bit settings of the ALS input select bits, bits [7:6] in the ALS Configuration register. The active ALS input can be the average of ALS1 and ALS2, the maximum of ALS1 and ALS2, ALS1 only, or ALS2 only. Once the ALS input select stage selects the active ALS input, the result is sent to the internal 8-bit ADC. For example, if the active ALS input select is set to be the average of ALS1 and ALS2, then the voltage at ALS1 and ALS2 is first averaged, then applied to the ADC. The output of the ADC (ADC Register) is the digitized average value of ALS1 and ALS2.

The LM3532 device's internal ADC samples at 7.143 ksps. ADC timing is shown in Figure 17. When the ALS is enabled (ALS Configuration Register bit [3] = 1) the ADC begins sampling and converting the active ALS input. Each conversion takes 140  $\mu$ s. After each conversion the ADC register is updated with new data.

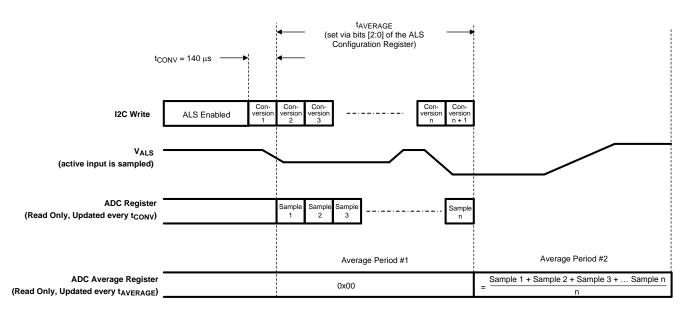


Figure 17. ADC Timing

#### 7.4.10.7 ALS ADC Readback

The digitized value of the LM3532 device's ADC is read back from the ADC Readback Register. Once the ALS is enabled, the ADC begins converting the active ALS input and updating the ALS Readback Register every 140 µs. The ADC Readback register contains the updated data after each conversion.



### 7.4.10.8 ALS Averaging

ALS averaging is used to filter out any fast changes in the ambient light sensor inputs. This prevents the backlight current from constantly changing due to rapid fluctuations in the ambient light. There are 8 separate averaging periods available for the ALS inputs (see Table 17). During an average period the ADC continually samples at 7.143 ksps. Therefore, during an average period, the ALS Averager output is the average of 7143/t<sub>AVE</sub>.

#### 7.4.10.9 ALS ADC Average Readback

The output of the LM3532's averager is read back via the Average ADC Register. This data is the ADC register data, averaged over the programmed ALS average time.

## 7.4.10.10 Initializing the ALS

On initial start-up of the ALS Block, the Ambient Light Zone defaults to Zone 0. This allows the ALS to start off in a predictable state. The drawback is that Zone 0 is often not representative of the true ALS Brightness Zone because the ALS inputs can get to their ambient light representative voltage much faster then the backlight is allowed to change. In order to avoid a multiple average time wait for the backlight current to get to its correct state, the LM3532 switches over to a fast average period (1.1 ms) on ALS startup. This quickly brings the ALS Brightness Zone (and the backlight current) to its correct setting (see Figure 18).

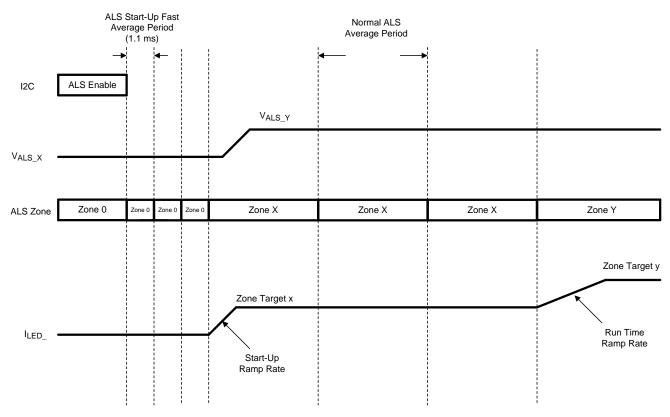


Figure 18. ALS Start-up Sequence

#### 7.4.10.11 ALS Operation

The LM3532's Ambient Light Sensor Interface has 3 different algorithms that can be used to control the ambient light to backlight current response.

#### **ALS Algorithms**

- 1. Direct ALS Control
- 2. Down Delay

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For each algorithm, the ALS follows these basic rules:

#### **ALS Rules**

- 1. For the ALS Interface to force a change in the backlight current (to a higher zone target), the averager output must have shown an increase for 3 consecutive average periods, or an increase and a remain at the new zone for 3 consecutive average periods.
- 2. For the ALS Interface to force a change in the backlight current (to a lower zone target), the averager output must have shown a decrease for 3 consecutive average periods, or a decrease and remain at the new zone for 3 consecutive average periods.
- 3. If condition 1 or condition 2 is satisfied, and during the next average period, the averager output changes again in the same direction as the last change, the LED current immediately changes at the beginning of the next average period.
- 4. If condition 1 or condition 2 is satisfied and the next average period shows no change in the average zone, or shows a change in the opposite direction, then the criteria in step 1 or step 2 must be satisfied again before the ALS interface can force a change in the backlight current.
- The Averager Output (see Figure 16) contains the zone that is determined from the most recent full average period.
- 6. The ALS Interface only forces a change in the backlight current at the beginning of an average period.
- 7. When the ALS forces a change in the backlight current the change is to the brightness target pointed to by the zone in the Averager Output.

#### 7.4.10.12 Direct ALS Control

In direct ALS control the LM3532's ALS Interface can force the backlight current to either a higher zone target or a lower zone target using the rules described in the ALS Rules Section.

Figure 19 shows the ALS voltage, the current average zone which is the zone determined by averaging the ALS voltage in the current average period, the Averager Output which is the zone determined from the previous full average period, and the target backlight current that is controlled by the ALS Interface. The following steps detail the Direct ALS algorithm:

- 1. When the ALS is enabled the ALS fast start-up (1.1ms average period) quickly brings the Averager Output to the correct zone. This takes 3 fast average periods or approximately 3.3 ms.
- 2. The 1st average period the ALS voltage averages to Zone 4.
- 3. The 2nd average period the ALS voltage averages to Zone 3.
- 4. The 3rd average period the ALS voltage averages to Zone 3 and the Averager Output shows a change from Zone 4 to Zone 3.
- 5. The 4th average period the ALS voltage averages to Zone 2 and the Averager Output remains at its changed state of Zone 3.
- 6. The 5th average period the ALS voltage averages to Zone 1. The Averager Output shows a change from Zone 3 to Zone 2. Because this is the 3rd average period that the Averager Output has shown a change in the decreasing direction from the initial Zone 4, the backlight current is forced to change to the current Averager Output (Zone 2's) target current.
- 7. The 6th average period the ALS voltage averages to Zone 2. The Averager Output changes from Zone 2 to Zone 1. Because this is in the same direction as the previous change, the backlight current is forced to change to the current Averager Output (Zone 1's) target current.
- 8. The 7th average period the ALS voltage averages to Zone 3. The Averager Output changes from Zone 1 to Zone 2. Because this change is in the opposite direction from the previous change, the backlight current remains at Zone 1's target.
- 9. The 8th average period the ALS voltage averages to Zone 3. The Averager Output changes from Zone 2 to Zone 3.
- 10. The 9th average period the ALS voltage averages to Zone 3. The Averager Output remains at Zone 3. Because this is the 3rd average period that the Averager Output has shown a change in the increasing direction from the initial Zone 1, the backlight current is forced to change to the current Averager Output (Zone 3's) target current.
- 11. The 10th average period the ALS voltage averages to Zone 4. The Averager Output remains at Zone 3.
- 12. The 11th average period the ALS voltage averages to Zone 4. The Averager Output changes to Zone 4.



- 13. The 12th average period the ALS voltage averages to Zone 4. The Averager Output remains at Zone 4.
- 14. The 13th average period the ALS voltage averages to Zone 4. The Averager Output remains at Zone 4. Because this is the 3rd average period that the Averager Output has shown a change in the increasing direction from the initial Zone 3, the backlight current is forced to change to the current Averager Output (Zone 4's) target current.

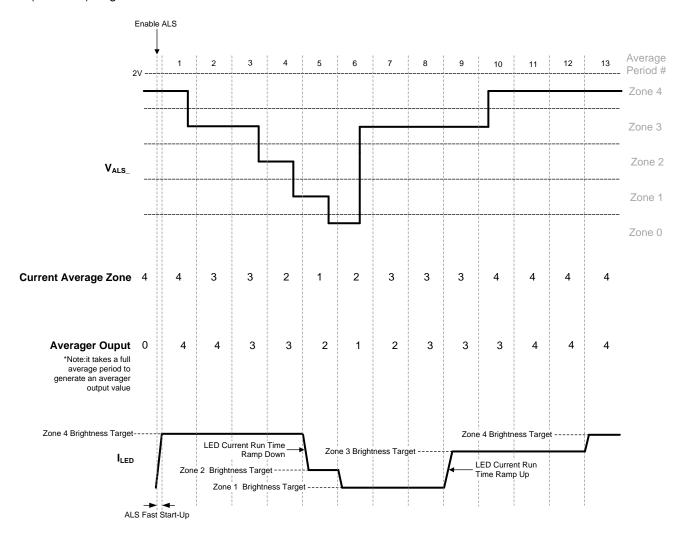


Figure 19. Direct ALS Control

#### 7.4.11 Down Delay

The down-delay algorithm uses all the same rules from the ALS Rules section, except it provides for adding additional average period delays required for decreasing transitions of the Averager Output, before the LED current is programmed to a lower zone target current. The additional average period delays are programmed via the ALS Down-Delay register. The register provides 32 settings for increasing the down delay from 3 extra (code 00000) up to 34 extra (code 11111). For example, if the down-delay algorithm is enabled, and the ALS Down-Delay register were programmed with 0x00 (3 extra delays), then the Averager Output would need to see 6 consecutive changes in decreasing Zones (or 6 consecutive average periods that changed and remained lower), before the backlight current was programmed to the lower zones target current. Referring to Figure 20, assume that Down Delay is enabled and the ALS Down-Delay register is programmed with 0x02 (5 extra delays, 8 average period total delay for downward changes in the backlight target current):

- 1. When the ALS is enabled the ALS fast start-up (1.1 ms average period) quickly brings the Averager Output to the correct zone. This takes 3 fast average periods or approximately 3.3 ms.
- 2. The first average period the ALS averages to Zone 3.

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- 3. The second average period the ALS averages to Zone 2. The Averager Output remains at Zone 3.
- 4. The 3rd through 7th average period the ALS input averages to Zone 2, and the Averager Output stays at Zone 2.
- 5. The 8th average period the ALS input averages to Zone 4. The Averager Output remains at Zone 2.
- 6. The 9th and 10th average periods the ALS input averages to Zone 4. The Averager Output is at Zone 4. Because the Averager Output increased from Zone 2 to Zone 4 and the required Down Delay time was not met (8 average periods), the backlight current was never changed to the Zone 2's target current.
- 7. The 11th average period the ALS input averages to Zone 2. The Averager Output remains at Zone 4. Because this is the 3rd consecutive average period where the Averager Output has shown a change since the change from Zone 2, the backlight current transitions to Zone 4's target current.
- 8. The 12th through 26th average periods the ALS input averages to Zone 2. The Averager Output remains at Zone 2. At the start of average period 20 the Down Delay algorithm has shown the required 8 average period delay from the initial change from Zone 4 to Zone 2. As a result the backlight current is programmed to Zone 2's target current.

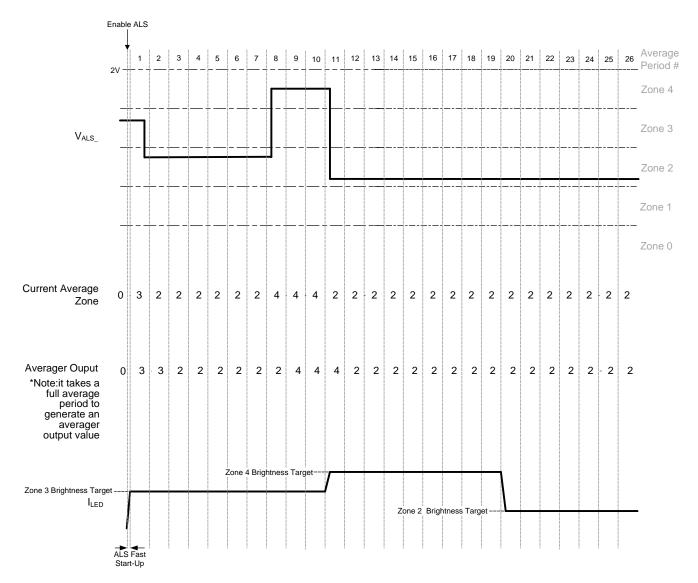


Figure 20. ALS Down-Delay Control

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## 7.5 Programming

## 7.5.1 I<sup>2</sup>C-Compatible Interface

#### 7.5.1.1 Start and Stop Conditions

The LM3532 is controlled via an I<sup>2</sup>C-compatible interface. START and STOP conditions classify the beginning and the end of the I<sup>2</sup>C session. A START condition is defined as SDA transitioning from HIGH-to-LOW while SCL is HIGH. A STOP condition is defined as SDA transitioning from LOW-to-HIGH while SCL is HIGH. The I<sup>2</sup>C master always generates the START and STOP conditions. The I<sup>2</sup>C bus is considered busy after a START condition and free after a STOP condition. During data transmission, the I<sup>2</sup>C master can generate repeated START conditions. A START and a repeated START conditions are equivalent function-wise. The data on SDA must be stable during the HIGH period of the clock signal (SCL). In other words, the state of SDA can only be changed when SCL is LOW.

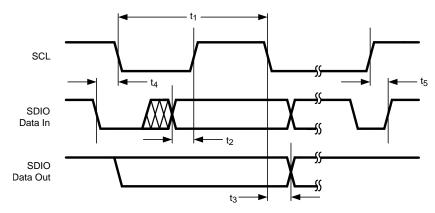


Figure 21. Start And Stop Sequences

### 7.5.1.2 PC-Compatible Address

The 7-bit chip address for the LM3532 is (0x38). After the START condition, the  $I^2C$  master sends the 7-bit chip address followed by an eighth bit (LSB) read or write (R/W). R/W = 0 indicates a WRITE and R/W = 1 indicates a READ. The second byte following the chip address selects the register address to which the data is written. The third byte contains the data for the selected register.

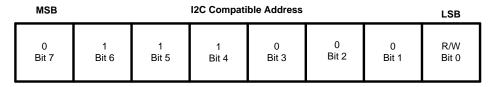


Figure 22. I<sup>2</sup>C-Compatible Chip Address (0x38)

### 7.5.1.3 Transferring Data

Every byte on the SDA line must be eight bits long, with the most significant bit (MSB) transferred first. Each byte of data must be followed by an acknowledge bit (ACK). The acknowledge related clock pulse (9th clock pulse) is generated by the master. The master then releases SDA (HIGH) during the 9th clock pulse. The LM3532 pulls down SDA during the 9th clock pulse, signifying an acknowledge. An acknowledge is generated after each byte has been received.



## 7.6 Register Maps

## Table 2. LM3532 Register Descriptions

PC Address         0x38 (7 bit), 0x70 for Write and 0x71 for Read           Output Configuration         0x10         0xE4           Startup/Shutdown Ramp Rate         0x11         0xC0           Run Time Ramp Rate         0x12         0xC0           Control A PWM         0x13         0x82           Control B PWM         0x14         0x82           Control A Brightness         0x16         0xF1           Control A Brightness         0x16         0xF1           Control B Brightness         0x16         0xF1           Control B Full-Scale Current         0x17         0xF3           Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x14         0xF1           Control C Full-Scale Current         0x19         0xF3           Control C Full-Scale Current         0x19         0xF3           Feedback Enable         0x1C         0xFF           Control C Full-Scale Current         0x10         0xFF           Control C Full-Scale Current         0x10         0xFF           Control C Pull-Scale Current         0x19         0xF           Control C Brightness         0x10         0xF           Control Enable         0x10         0	Table 2. LM3532 Register Descriptions						
Output Configuration         0x10         0xE4           Startup/Shutdown Ramp Rate         0x11         0xC0           Bun Time Ramp Rate         0x12         0xC0           Control A PWM         0x13         0x82           Control A PWM         0x14         0x82           Control C PWM         0x15         0x82           Control A Full-Scale Current         0x15         0x82           Control A Full-Scale Current         0x17         0xF3           Control B Brightness         0x18         0xF1           Control B Full-Scale Current         0x19         0xF3           Control C Full-Scale Current         0x19         0xF3           Control C Full-Scale Current         0x18         0xF1           Control C Full-Scale Current         0x18         0xF1           Control C Full-Scale Current         0x18         0xF3           Control C Full-Scale Current         0x18         0xF3           Control C Full-Scale Current         0x18         0xF1           Control C Full-Scale Current         0x18         0xF3           Control C Full-Scale Current         0x18         0xF3           Control C Full-Scale Current         0x18         0xF3           Control C Full-Scale Curr	NAME	ADDRESS	POWER-ON RESET				
Startup/Shutdown Ramp Rate   0x11		· /·	2.54				
Run Time Ramp Rate         0x12         0xC0           Control A PWM         0x13         0x82           Control B PWM         0x14         0x82           Control C PWM         0x15         0x82           Control A Brightness         0x16         0xF1           Control B Brightness         0x18         0xF1           Control B Full-Scale Current         0x19         0xF3           Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1C         0xFF           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x20         0xE0           ALS Down Delay         0x22         0xE0           ALS Down Delay         0x23         0x44           ALS Down Delay         0x23         0x44           ALS Down Brightness Zon	-						
Control A PWM 0x13 0x82 Control B PWM 0x14 0x82 Control C PWM 0x15 0x82 Control A Fightness 0x16 0x61 Control A Fightness 0x16 0x67 Control B Brightness 0x18 0x17 Control B Brightness 0x18 0x71 Control B Fightness 0x18 0x71 Control C Brightness 0x1A 0x71 Control C Fightness 0x1A 0x1A 0x1B 0x1B 0x1B 0x1B 0x1B 0x1B 0x1B 0x1B							
Control B PWM         0x14         0x82           Control C PWM         0x15         0x82           Control A Brightness         0x16         0xF1           Control A Brightness         0x18         0xF3           Control B Brightness         0x18         0xF1           Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           LS1 Resistor Select         0x20         0xE0           ALS1 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary O High         0x60         0x35           ALS Zone Boundary 1 High         0x6							
Control C PWM         0x15         0x82           Control A Brightness         0x16         0xF1           Control B Fightness         0x18         0xF1           Control B Brightness         0x18         0xF1           Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ALS Zone Boundary O High         0x60         0x35           ALS Zone Boundary 1 High         0x60<		0x13					
Control A Brightness         0x16         0xF1           Control A Full-Scale Current         0x17         0xF3           Control B Brightness         0x18         0xF1           Control B Fightness         0x14         0xF1           Control C Full-Scale Current         0x1B         0xF3           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary O High         0x60         0x35           ALS Zone Boundary O Low         0x61         0x33           ALS Zone Boundary 1 Low         0x63         0x66           ALS Zone Boundary 2 Low							
Control A Full-Scale Current         0x17         0xF3           Control B Brightness         0x18         0xF1           Control C Brightness         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Brightness         0x1B         0xF3           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS2 Resistor Select         0x22         0xE0           ALS2 Resistor Select         0x22         0xE0           ALS2 Resistor Select         0x22         0xE0           ALS2 Resistor Select         0x24         0xF0           ALS Brightness         0x06         0x72           0x00	Control C PWM						
Control B Brightness         0x18         0xF1           Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Configuration         0x23         0x44           ALS Configuration         0x23         0xF6           ALS Configuration         0x23         0xF6           ALS Configuration         0x23         0xF6           ALS Configuration         0x23         0xF6           ALS Configuration         0x24         0xF0           ALS Configuration         0x24         0xF0           ALS Configuration         0x22         0xF8           ALS Configuration         0x25         0xF8           ALS Come Information         0x24         0xF0           ALS Brightness Zone         <	Control A Brightness	0x16	0xF1				
Control B Full-Scale Current         0x19         0xF3           Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary 0 High         0x60         0x35           ALS Zone Boundary 1 Low         0x61         0x33           ALS Zone Boundary 1 High         0x62         0x6A           ALS Zone Boundary 2 High         0x62         0x6A           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 2 High         0x66         0xDC           ALS Zone Boundary 3 Low         0x66         0xDC           ALS Zone		0x17	0xF3				
Control C Brightness         0x1A         0xF1           Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary 0 High         0x60         0x35           ALS Zone Boundary 1 High         0x60         0x33           ALS Zone Boundary 1 High         0x62         0x6A           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone B	Control B Brightness	0x18	0xF1				
Control C Full-Scale Current         0x1B         0xF3           Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary 0 High         0x60         0x35           ALS Zone Boundary 1 High         0x60         0x33           ALS Zone Boundary 1 High         0x62         0x6A           ALS Zone Boundary 2 High         0x62         0x6A           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Target	Control B Full-Scale Current	0x19	0xF3				
Feedback Enable         0x1C         0xFF           Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zonfiguration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ADC Average         0x28         0x00           ALS Zone Boundary 0 High         0x60         0x35           ALS Zone Boundary 1 High         0x60         0x33           ALS Zone Boundary 1 Low         0x61         0x33           ALS Zone Boundary 1 Low         0x63         0x66           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 3 High         0x64         0xDC           ALS Zone Boundary 3 Low         0x65         0x99           ALS Zone Boundary 3 Low         0x66         0xDC           ALS Zone Target 1         0x71         0x33           Control A Zone Target 2	Control C Brightness	0x1A	0xF1				
Control Enable         0x1D         0xF8           ALS1 Resistor Select         0x20         0xE0           ALS2 Resistor Select         0x21         0xE0           ALS Down Delay         0x22         0xE0           ALS Configuration         0x23         0x44           ALS Zone Information         0x24         0xF0           ALS Brightness Zone         0x25         0xF8           ADC         0x27         0x00           ALS ADC         0x28         0x00           ALS Zone Boundary 0 High         0x60         0x35           ALS Zone Boundary 1 High         0x60         0x33           ALS Zone Boundary 1 Low         0x61         0x33           ALS Zone Boundary 1 Low         0x63         0x66           ALS Zone Boundary 2 High         0x64         0xA1           ALS Zone Boundary 3 High         0x64         0xDC           ALS Zone Boundary 3 High         0x66         0xDC           ALS Zone Boundary 3 Low         0x67         0xCC           Control A Zone Target 0         0x70         0x33           Control A Zone Target 1         0x71         0x66           Control A Zone Target 2         0x72         0x99           Control A Z	Control C Full-Scale Current	0x1B	0xF3				
ALS1 Resistor Select 0x20 0xE0  ALS2 Resistor Select 0x21 0xE0  ALS Down Delay 0x22 0xE0  ALS Configuration 0x23 0x44  ALS Zone Information 0x24 0xF0  ALS Brightness Zone 0x25 0xF8  ADC 0x27 0x00  ALS Zone Boundary 0 High 0x60 0x35  ALS Zone Boundary 0 Low 0x61 0x33  ALS Zone Boundary 1 High 0x62 0x6A  ALS Zone Boundary 1 Low 0x63 0x66  ALS Zone Boundary 2 Low 0x63 0x66  ALS Zone Boundary 2 Low 0x65 0x99  ALS Zone Boundary 3 High 0x66 0x01  ALS Zone Boundary 3 High 0x66 0x02  ALS Zone Boundary 3 High 0x66 0x0C  Control A Zone Target 0 0x70 0x33  Control A Zone Target 1 0x71 0x66  Control A Zone Target 2 0x99  Control A Zone Target 3 0x72 0x99  Control A Zone Target 4 0x74 0xFF  Control B Zone Target 0 0x75 0x33	Feedback Enable	0x1C	0xFF				
ALS2 Resistor Select       0x21       0xE0         ALS Down Delay       0x22       0xE0         ALS Configuration       0x23       0x44         ALS Zone Information       0x24       0xF0         ALS Brightness Zone       0x25       0xF8         ADC       0x27       0x00         ADC Average       0x28       0x00         ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 1 Low       0x61       0x33         ALS Zone Boundary 1 Low       0x62       0x6A         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 3       0x72       0x99         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	Control Enable	0x1D	0xF8				
ALS Down Delay       0x22       0xE0         ALS Configuration       0x23       0x44         ALS Zone Information       0x24       0xF0         ALS Brightness Zone       0x25       0xF8         ADC       0x27       0x00         ADC Average       0x28       0x00         ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 1 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x72       0x99         Control B Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS1 Resistor Select	0x20	0xE0				
ALS Configuration       0x23       0x44         ALS Zone Information       0x24       0xF0         ALS Brightness Zone       0x25       0xF8         ADC       0x27       0x00         ADC Average       0x28       0x00         ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 1 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x72       0x99         Control B Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS2 Resistor Select	0x21	0xE0				
ALS Zone Information       0x24       0xF0         ALS Brightness Zone       0x25       0xF8         ADC       0x27       0x00         ADC Average       0x28       0x00         ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 1 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control B Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Down Delay	0x22	0xE0				
ALS Brightness Zone       0x25       0xF8         ADC       0x27       0x00         ADC Average       0x28       0x00         ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 0 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Configuration	0x23	0x44				
ADC	ALS Zone Information	0x24	0xF0				
ADC Average	ALS Brightness Zone	0x25	0xF8				
ALS Zone Boundary 0 High       0x60       0x35         ALS Zone Boundary 0 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ADC	0x27	0x00				
ALS Zone Boundary 0 Low       0x61       0x33         ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ADC Average	0x28	0x00				
ALS Zone Boundary 1 High       0x62       0x6A         ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Zone Boundary 0 High	0x60	0x35				
ALS Zone Boundary 1 Low       0x63       0x66         ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Zone Boundary 0 Low	0x61	0x33				
ALS Zone Boundary 2 High       0x64       0xA1         ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Zone Boundary 1 High	0x62	0x6A				
ALS Zone Boundary 2 Low       0x65       0x99         ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Zone Boundary 1 Low	0x63	0x66				
ALS Zone Boundary 3 High       0x66       0xDC         ALS Zone Boundary 3 Low       0x67       0xCC         Control A Zone Target 0       0x70       0x33         Control A Zone Target 1       0x71       0x66         Control A Zone Target 2       0x72       0x99         Control A Zone Target 3       0x73       0xCC         Control A Zone Target 4       0x74       0xFF         Control B Zone Target 0       0x75       0x33	ALS Zone Boundary 2 High	0x64	0xA1				
ALS Zone Boundary 3 Low         0x67         0xCC           Control A Zone Target 0         0x70         0x33           Control A Zone Target 1         0x71         0x66           Control A Zone Target 2         0x72         0x99           Control A Zone Target 3         0x73         0xCC           Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	ALS Zone Boundary 2 Low	0x65	0x99				
Control A Zone Target 0         0x70         0x33           Control A Zone Target 1         0x71         0x66           Control A Zone Target 2         0x72         0x99           Control A Zone Target 3         0x73         0xCC           Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	ALS Zone Boundary 3 High	0x66	0xDC				
Control A Zone Target 1         0x71         0x66           Control A Zone Target 2         0x72         0x99           Control A Zone Target 3         0x73         0xCC           Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	ALS Zone Boundary 3 Low	0x67	0xCC				
Control A Zone Target 2         0x72         0x99           Control A Zone Target 3         0x73         0xCC           Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	Control A Zone Target 0	0x70	0x33				
Control A Zone Target 3         0x73         0xCC           Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	Control A Zone Target 1	0x71	0x66				
Control A Zone Target 4         0x74         0xFF           Control B Zone Target 0         0x75         0x33	Control A Zone Target 2	0x72	0x99				
Control B Zone Target 0         0x75         0x33	Control A Zone Target 3	0x73	0xCC				
	Control A Zone Target 4	0x74	0xFF				
Control B Zone Target 1 0x76 0x66	Control B Zone Target 0	0x75	0x33				
<u> </u>	Control B Zone Target 1	0x76	0x66				
Control B Zone Target 2 0x77 0x99	Control B Zone Target 2	0x77	0x99				
Control B Zone Target 3 0x78 0xCC	Control B Zone Target 3	0x78	0xCC				
Control B Zone Target 4 0x79 0xFF	Control B Zone Target 4	0x79	0xFF				
Control C Zone Target 0 0x7A 0x33	Control C Zone Target 0	0x7A	0x33				
Control C Zone Target 1 0x7B 0x66	Control C Zone Target 1	0x7B	0x66				
Control C Zone Target 2 0x7C 0x99	Control C Zone Target 2	0x7C	0x99				
Control C Zone Target 3 0x7D 0xCC	Control C Zone Target 3	0x7D	0xCC				
Control C Zone Target 4 0x7E 0xFF	Control C Zone Target 4	0x7E	0xFF				

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### 7.6.1 Output Configuration

Table 3 configures how the three control banks are routed to the current sinks (ILED1, ILED2, ILED3)

Table 3. Output Configuration Register Description (Address 0x10)

Bit [7:6]	Bits [5:4]	Bits [3:2]	Bits [1:0]
	ILED3 Control	ILED2 Control	ILED1 Control
Not Used	00 = ILED3 is controlled by Control A PWM and Control A Brightness Registers 01 = ILED3 is controlled by Control B PWM and Control B Brightness Registers 1X = ILED3 is controlled by Control C PWM and Control C Brightness Registers (default)	00 = ILED2 is controlled by Control A PWM and Control A Brightness Registers 01 = ILED2 is controlled by Control B PWM and Control B Brightness Registers (default) 1X = ILED2 is controlled by Control C PWM and Control C Brightness Registers	00 = ILED1 is controlled by Control A PWM and Control A Brightness Registers (default) 01 = ILED1 is controlled by Control B PWM and Control B Brightness Registers 1X = ILED1 is controlled by Control C PWM and Control C Brightness Registers

### 7.6.2 Start-up/Shutdown Ramp Rate

This register controls the ramping of the LED current in current sinks ILED1, ILED2, and ILED3 during start-up and shutdown. The startup ramp rates/step are from when the device is enabled via I<sup>2</sup>C to when the target current is reached. The Shutdown ramp rates/step are from when the device is shut down via I<sup>2</sup>C until the LED current is 0. To start up and shut down the current sinks via I<sup>2</sup>C (see Equation 6).

Table 4. Start-up/Shutdown Ramp Rate Register Description (Address 0x11)

Bits [7:6]	Bits [5:3] Shutdown Ramp	Bits [2:0] Startup Ramp
Not Used	000 = 8µs/step (2.048ms from Full-Scale to 0) (default) 001 = 1.024 ms/step (261 ms) 010 = 2.048 ms/step (522 ms) 011 = 4.096 ms/step (1.044s) 100 = 8.192 ms/step (2.088s) 101 = 16.384 ms/step (4.178s) 110 = 32.768 ms/step (8.356s) 111 = 65.536 ms/step (16.711s)	000 = 8µs/step (2.048ms from Full-Scale to 0) (default) 001 = 1.024 ms/step (261ms) 010 = 2.048 ms/step (522ms) 011 = 4.096 ms/step (1.044s) 100 = 8.192 ms/step (2.088s) 101 = 16.384 ms/step (4.178s) 110 = 32.768 ms/step (8.356s) 111 = 65.536 ms/step (16.711s)

## 7.6.3 Run-Time Ramp Rate

This register controls the ramping of the current in current sinks ILED1, ILED2, and ILED3. The Run Time ramp rates/step are from one current set-point to another after the device has reached its initial target set point from turn-on.

Table 5. Run Time Ramp Rate Register Description (Address 0x12)

Bits [7:6]	Bits [5:3] Ramp Down	Bits [2:0] Ramp Up
Not Used	000 = 8µs/step (default) 001 = 1.024 ms/step 010 = 2.048 ms/step 011 = 4.096 ms/step 100 = 8.192 ms/step 101 = 16.384 ms/step 110 = 32.768 ms/step 111 = 65.536 ms/step	000 = 8µs/step (default) 001 = 1.024 ms/step 010 = 2.048 ms/step 011 = 4.096 ms/step 100 = 8.192 ms/step 101 = 16.384 ms/step 110 = 32.768 ms/step 111 = 65.536 ms/step



### 7.6.4 Control A PWM

This register configures which PWM input (PWM1 or PWM2) is mapped to Control Bank A and which zones the selected PWM input is active in.

Table 6. Control A Pwm Register Description (Address 0x13)

Bit 7 N/A	Bit 6 Zone 4 PWM Enable	Bit 5 Zone 3 PWM Enable	Bit 2 Zone 2 PWM Enable	Bit 2 Zone 1 PWM Enable	Bit 2 Zone 0 PWM Enable	Bit 1 PWM Input Polarity	Bit 0 PWM Select
Not Used	0 = Active PWM input is disabled in Zone 4 (default)	0 = Active PWM input is disabled in Zone 3 (default)	0 = Active PWM input is disabled in Zone 2 (default)	0 = Active PWM input is disabled in Zone 1 (default)	0 = Active PWM input is disabled in Zone 0 (default)		0 = PWM1 input is mapped to Control Bank A (default)
	1 = Active PWM input is enabled in Zone 4	1 = Active PWM input is enabled in Zone 3	1 = Active PWM input is enabled in Zone 2	1 = Active PWM input is enabled in Zone 1	1 = Active PWM input is enabled in Zone 0	1 = active high polarity (default)	1 = PWM2 is mapped to Control Bank A

#### 7.6.5 Control B PWM

This register configures which PWM input (PWM1 or PWM2) is mapped to Control Bank B and which zones the selected PWM input is active in.

Table 7. Control B Pwm Register Description (Address 0x14)

Bit 7 N/A	Bit 6 Zone 4 PWM Enable	Bit 5 Zone 3 PWM Enable	Bit 2 Zone 2 PWM Enable	Bit 2 Zone 1 PWM Enable	Bit 2 Zone 0 PWM Enable	Bit 1 PWM Input Polarity	Bit 0 PWM Select
Not Used	0 = Active PWM input is disabled in Zone 4 (default)	0 = Active PWM input is disabled in Zone 3 (default)	0 = Active PWM input is disabled in Zone 2 (default)	0 = Active PWM input is disabled in Zone 1 (default)	0 = Active PWM input is disabled in Zone 0 (default)	0 = active low polarity	0 = PWM1 input is mapped to Control Bank B (default)
	1 = Active PWM input is enabled in Zone 4	1 = Active PWM input is enabled in Zone 3	1 = Active PWM input is enabled in Zone 2	1 = Active PWM input is enabled in Zone 1	1 = Active PWM input is enabled in Zone 0	1 = active high polarity (default)	1 = PWM2 is mapped to Control Bank B

#### 7.6.6 Control C PWM

This register configures which PWM input (PWM1 or PWM2) is mapped to Control Bank C and which zones the selected PWM input is active in.

Table 8. Control C Pwm Register Description (Address 0x15)

Bit 7 N/A	Bit 6 Zone 4 PWM Enable	Bit 5 Zone 3 PWM Enable	Bit 2 Zone 2 PWM Enable	Bit 2 Zone 1 PWM Enable	Bit 2 Zone 0 PWM Enable	Bit 1 PWM Input Polarity	Bit 0 PWM Select
Not Used	0 = Active PWM input is disabled in Zone 4 (default)	0 = Active PWM input is disabled in Zone 3 (default)	0 = Active PWM input is disabled in Zone 2 (default)	0 = Active PWM input is disabled in Zone 1 (default)	0 = Active PWM input is disabled in Zone 0 (default)	0 = active low polarity	0 = PWM1 input is mapped to Control Bank C (default)
	1 = Active PWM input is enabled in Zone 4	1 = Active PWM input is enabled in Zone 3	1 = Active PWM input is enabled in Zone 2	1 = Active PWM input is enabled in Zone 1	1 = Active PWM input is enabled in Zone 0	1 = active high polarity (default)	1 = PWM2 is mapped to Control Bank C

### 7.6.7 Control A Brightness Configuration

The Control A Brightness Configuration Register has 3 functions:

1. Selects how the LED current sink which is mapped to Control Bank A is controlled (either directly through the I<sup>2</sup>C or via the ALS interface).



- 2. Programs the LED current mapping mode for Control Bank A (Linear or Exponential).
- 3. Programs which Control A Zone Target Register is the Brightness Register for Bank A in I<sup>2</sup>C Current Control.

Table 9. Control A Brightness Configuration Register Description (Address 0x16)

Bits [7:5] Not Used	Bits [4:2] Control A Brightness Pointer (I <sup>2</sup> C Current Control Only)	Bit 1 LED Current Mapping Mode	Bit 0 Bank A Current Control
N/A	000 = Control A Zone Target 0 001 = Control A Zone Target 1 010 = Control A Zone Target 2 011 = Control A Zone Target 3 1XX = Control A Zone Target 4 (default)	0 = Exponential Mapping (default) 1 = Linear Mapping	0 = ALS Current Control 1 = I <sup>2</sup> C Current Control ( <b>default</b> )

## 7.6.8 Control B Brightness Configuration

The Control B Brightness Configuration Register has 3 functions:

- 1. Selects how the LED current sink which is mapped to Control Bank B is controlled (either directly through the I<sup>2</sup>C or via the ALS interface).
- 2. Programs the LED current mapping mode for Control Bank B (Linear or Exponential).
- 3. Programs which Control B Zone Target Register is the Brightness Register for Bank B in I<sup>2</sup>C Current Control.

Table 10. Control B Brightness Configuration Register Description (Address 0x18)

Bits [7:5] Not Used	Bits [4:2] Control A Brightness Pointer (I <sup>2</sup> C Current Control Only)	Bit 1 LED Current Mapping Mode	Bit 0 Bank B Current Control
N/A	000 = Control B Zone Target 0 001 = Control B Zone Target 1 010 = Control B Zone Target 2 011 = Control B Zone Target 3 1XX = Control B Zone Target 4 (default)	0 = Exponential Mapping (default) 1 = Linear Mapping	0 = ALS Current Control 1 = I <sup>2</sup> C Current Control (default)



## 7.6.9 Control C Brightness Configuration

The Control C Brightness Configuration Register has 3 functions:

- 1. Selects how the LED current sink which is mapped to Control Bank C is controlled (either directly through the I<sup>2</sup>C or via the ALS interface)
- 2. Programs the LED current mapping mode for Control Bank C (Linear or Exponential)
- 3. Programs which Control C Zone Target Register is the Brightness Register for Bank C in I<sup>2</sup>C Current Control

Table 11. Control C Brightness Configuration Register Description (Address 0x1a)

Bits [7:5] Not Used	Bits [4:2] Control C Brightness Pointer (I <sup>2</sup> C Current Control Only)	Bit 1 LED Current Mapping Mode	Bit 0 Bank C Current Control
N/A	000 = Control C Zone Target 0 001 = Control C Zone Target 1 010 = Control C Zone Target 2 011 = Control C Zone Target 3 1XX = Control C Zone Target 4 (default)	0 = Exponential Mapping (default) 1 = Linear Mapping	0 = ALS Current Control 1 = I <sup>2</sup> C Current Control (default)

### 7.6.10 Control A, B, and C Full-Scale Current

These registers program the full-scale current setting for the current sink(s) assigned to Control Bank A, B, and C. Each Control Bank has its own full-scale current setting (Control Bank A, Address 0x17), (Control Bank B, address 0x19), (Control Bank C, address 0x1B).



Table 12. Control A/B/C Full-Scale Current Registers Descriptions (Address 0x17, 0x19, 0x1b)

Bits [7:5] Not Used	Bits [4:0] Control A/B/C Full-Scale Current Select Bits
	00000 = 5 mA
	00001 = 5.8  mA
	00010 = 6.6  mA
	00011 = 7.4  mA
	00100 = 8.2  mA
	00101 = 9  mA
	00110 = 9.8  mA
	00111 = 10.6 mA
	01000 = 11.4 mA
	01001 = 12.2  mA
	01010 = 13 mA
	01011 = 13.8 mA
	01100 = 14.6 mA
	01101 = 15.4 mA
	01110 = 16.2 mA
N/A	01111 = 17 mA
IN/A	10000 = 17.8 mA
	10001 = 18.6mA
	10010 = 19.4 mA
	10011 = 20.2 mA (default)
	10100 = 21 mA
	10101 = 21.8 mA
	10110 = 22.6 mA
	10111 = 23.4 mA
	11000 = 24.2 mA
	11001 = 25 mA
	11010 = 25.8 mA
	11011 = 26.6 mA
	11100 = 27.4 mA
	11101 = 28.2 mA
	11110 = 29 mA
	11111 = 29.8 mA

### 7.6.11 Feedback Enable

The Feedback Enable Register configures which current sinks are or are not part of the boost control loop.

Table 13. Feedback Enable Register Description (Address 0x1c)

Bits [7:3]	Bit 2	Bit 1	Bit 0
Not Used	ILED3 Feedback Enable	ILED2 Feedback Enable	ILED1 Feedback Enable
N/A	0 = ILED3 is not part of the	0 = ILED2 is not part of the	0 = ILED1 is not part of the
	boost control loop	boost control loop	boost control loop
	1 = ILED3 is part of the boost	1 = ILED2 is part of the	1 = ILED1 is part of the
	control loop (default)	boost control loop (default)	boost control loop (default)



#### 7.6.12 Control Enable

The Control Enable register contains the bits to turn on/off the individual Control Banks (A, B, or C). Once one of these bits is programmed high, the current sink(s) assigned to the selected control banks are enabled.

Table 14. Control Enable Register Description (Address 0x1d)

Bits (7:3)	Bit 2	Bit 1	Bit 0
(Not Used)	Control C Enable	Control B Enable	Control A Enable
N/A	0 = Control C is disabled (default) 1 = Control C is enabled		0 = Control A is disabled (default) 1 = Control A is enabled

#### 7.6.13 ALS1 and ALS2 Resistor Select

The ALS Resistor Select Registers program the internal pulldown resistor at the ALS1/ALS2 input. Each ALS input has its own resistor select register (ALS1 Resistor Select Register, Address 0x20) and (ALS2 Resistor Select Register, Address 0x21). Each ALS input can be set independent of the other. There are 32 available resistors including a high impedance setting. The full-scale input voltage range at either ALS input is 2V.

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Table 15. ALS Resistor Select Register Description (Address 0x20, Address 0x21)

Bit [7:5] Not Used	Bit [4:0] ALS1/ALS2 Resistor Select Bits
	00000 = High Impedance (default)
	$00001 = 37 \text{ k}\Omega$
	$00010 = 18.5 \text{ k}\Omega$
	$00011 = 12.33 \text{ k}\Omega$
	$00100 = 9.25 \text{ k}\Omega$
	$00101 = 7.4 \text{ k}\Omega$
	$00110 = 6.17 \text{ k}\Omega$
	$00111 = 5.29 \text{ k}\Omega$
	$01000 = 4.63 \text{ k}\Omega$
	$01001 = 4.11 \text{ k}\Omega$
	$01010 = 3.7 \text{ k}\Omega$
	$01011 = 3.36 \text{ k}\Omega$
	$01100 = 3.08 \text{ k}\Omega$
	$01101 = 2.85 \text{ k}\Omega$
	$01110 = 2.64 \text{ k}\Omega$
N/A	$01111 = 2.44 \text{ k}\Omega$
14/71	10000 = 2.31 kΩ
	10001 = 2.18  kΩ
	$10010 = 2.06 \text{ k}\Omega$
	$10011 = 1.95 \text{ k}\Omega$
	$10100 = 1.85 \text{ k}\Omega$
	$10101 = 1.76 \text{ k}\Omega$
	$10110 = 1.68 \text{ k}\Omega$
	$10111 = 1.61 \text{ k}\Omega$
	11000 = 1.54 kΩ
	11001 = 1.48 kΩ
	$11010 = 1.42 \text{ k}\Omega$
	11011 = 1.37 kΩ
	11100 = 1.32 kΩ
	11101 = 1.28 kΩ
	11110 = 1.23 kΩ
	$11111 = 1.19 \text{ k}\Omega$

## 7.6.14 ALS Down Delay

The ALS Down-Delay Register adds additional average time delays for ALS changes in the backlight current during falling ALS input voltages. Code 00000 adds 3 extra average period delays on top of the 3 default delays (6 total). Code 11111 adds 34 extra average period delays.

Table 16. ALS Down Delay Register Description (Address 0x22)

Bits [7:6]	Bit [5]	Bits [4:0]	
Not Used	ALS Fast Start-up Enable	Down Delay	
N/A	0 = ALS Fast start-up is Disabled 1 = ALS Fast start-up is Enabled ( <b>default</b> )	00000 = 6 total average period delay for down-delay control (default) : : : : 11111 = 34 total average periods of delay for down delay control	

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### 7.6.15 ALS Configuration

The ALS Configuration register controls the ALS average times, the ALS enable bit, and the ALS input select.

Table 17. ALSConfiguration Register Description (Address 0x23)

Bits [7:6]	Bit [5:4]	Bit 3	Bits [2:0]
ALS Input Select	ALS Control	ALS Enable	ALS Average Time
00 = Average of ALS1 and ALS2 is used to determine backlight current 01 = Only the ALS1 input is used to determine backlight current (default) 10 = Only the ALS2 input is used to determine the backlight current 11 = The maximum of ALS1 and ALS2 is used to determine the backlight current	00 = Direct ALS Control. ALS inputs respond to up and down transitions (default) 01 = This setting is for a future mode. 1X = Down Delay Control. Extra delays of 3 x t <sub>AVE</sub> to 34 x t <sub>AVE</sub> are added for down transitions, before the new backlight target is programmed. (see Down Delay section).	0 = ALS is disabled (default) 1 = ALS is enabled	000 = 17.92 ms 001 = 35.84 ms 010 = 71.68 ms 011 = 143.36 ms 100 = 286.72 ms (default) 101 = 573.44 ms 110 = 1146.88 ms 111 = 2293.76 ms

#### 7.6.16 ALS Zone Readback / Information

The ALS Zone Readback and ALS Zone Information Readback registers each contain information on the current ambient light brightness zone. The ALS Zone Readback register contains the ALS Zone after the averager and discriminator block and reflects both up and down changes in the ambient light brightness zone. The ALS Zone Information register reflects the contents of either the ALS Zone Readback register (with up and down transition). This register also includes a Zone Change bit (bit 3) which is written with a 1 each time the ALS zone changes. This bit is cleared upon read back of the ALS Zone Information register.

Table 18. ALS Zone Information Register Description (Address 0x24)

Bits [7:4] Not Used	Bit 3 Zone Change Bit	Bits [2:0] Brightness Zone
N/A	<ul> <li>0 = No change in ALS Zone (default)</li> <li>1 = There was a change in the ALS Zone since the last read of this register. This bit is cleared on read back.</li> </ul>	000 = Zone 0 (default) 001 = Zone 1 010 = Zone 2 011 = Zone 3 1XX = Zone 4

Table 19. ALS Zone Readback Register Description (Address 0x25)

Bits [7:3]	Bits [2:0]			
Not Used	Brightness Zone			
N/A	000 = Zone 0 (default) 001 = Zone 1 010 = Zone 2 011 = Zone 3 1XX = Zone 4			



#### 7.6.17 ALS Zone Boundaries

There are 4 ALS Zone Boundary registers which form the boundaries for the 5 Ambient Light Zones. Each Zone Boundary register is 8 bits with a maximum voltage of 2V. This gives a step size for each Zone Boundary Register bit of:

ZoneBoundaryLSB = 
$$\frac{2V}{255}$$
 = 7.8 mV (4)

ALS Zone Boundary 0 High (Address 0x60), <b>default = 0x35 (415.7 mV)</b>
ALS Zone Boundary 0 Low (Address 0x61), <b>default = 0x33 (400 mV)</b>
ALS Zone Boundary 1 High (Address 0x62), <b>default = 0x6A (831.4 mV)</b>
ALS Zone Boundary 1 Low (Address 0x63), <b>default = 0x66 (800 mV)</b>
ALS Zone Boundary 2 High (Address 0x64), <b>default = 0xA1 (1262.7 mV)</b>
ALS Zone Boundary 2 Low (Address 0x65), <b>default = 0x99 (1200 mV)</b>
ALS Zone Boundary 3 High (Address 0x66), <b>default = 0xDC (1725.5 mV)</b>
ALS Zone Boundary 3 Low (Address 0x67), default = 0xCC (1600 mV)

### 7.6.18 Zone Target Registers

There are 3 groups of Zone Target Registers (Control A, Control B, and Control C). The Zone Target registers have 2 functions. In Ambient Light Current control, they map directly to the corresponding ALS Zone. When the active ALS input lands within the programmed Zone, the backlight current is programmed to the corresponding zone target registers set point (see below).

	Control A Zone Target Register 0 maps directly to Zone 0 (Address 0x70)
	Control A Zone Target Register 1 maps directly to Zone 1 (Address 0x71)
	Control A Zone Target Register 2 maps directly to Zone 2 (Address 0x72)
	Control A Zone Target Register 3 maps directly to Zone 3 (Address 0x73)
	Control A Zone Target Register 4 maps directly to Zone 4 (Address 0x74)
	Control B Zone Target Register 0 maps directly to Zone 0 (Address 0x75)
	Control B Zone Target Register 1 maps directly to Zone 1 (Address 0x76)
	Control B Zone Target Register 2 maps directly to Zone 2 (Address 0x77)
	Control B Zone Target Register 3 maps directly to Zone 3 (Address 0x78)
	Control B Zone Target Register 4 maps directly to Zone 4 (Address 0x79)
	Control C Zone Target Register 0 maps directly to Zone 0 (Address 0x7A)
	Control C Zone Target Register 1 maps directly to Zone 1 (Address 0x7B)
	Control C Zone Target Register 2 maps directly to Zone 2 (Address 0x7C)
	Control C Zone Target Register 3 maps directly to Zone 3 (Address 0x7D)
	Control C Zone Target Register 4 maps directly to Zone 4 (Address 0x7E)
-	

In I<sup>2</sup>C Current Control, any of the 5 Zone Target Registers for the particular Control Bank can be the LED brightness registers. This is set according to Control A, B, or C Brightness Configuration Registers (Bits [4:2]).



## 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 8.1 Application Information

The LM3532 incorporates a 40-V (maximum output) boost, three high-voltage, low-side current sinks, and programmable dual ambient light sensor inputs with internal-sensor gain selection. The device can drive up to 3 parallel high-voltage LED strings with up to 90% efficiency. The adaptive current regulation method allows for different LED currents in each current sink, thus allowing for a wide variety of backlight-with-keypad applications.

## 8.2 Typical Application

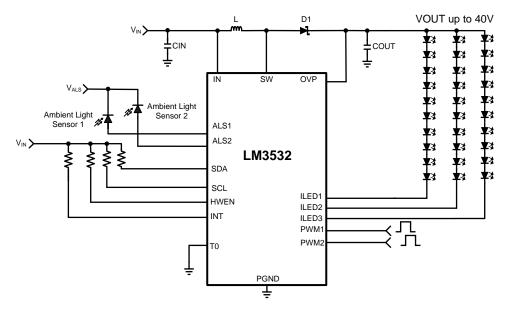


Figure 23. LM3532 Typical Application

#### 8.2.1 Design Requirements

For typical white LED applications, use the parameters listed in Table 20:

**Table 20. Design Parameters** 

DESIGN PARAMETER	EXAMPLE VALUE
Input voltage range	2.7 V to 5.5 V
Output current	500 MHz typical
Boost switching frequency	2 MHz



### 8.2.2 Detailed Design Procedure

**Table 21. Suggested Application Circuit Component List** 

COMPONENT	MANUFACTURER'S PART NUMBER	VALUE	SIZE	CURRENT/VOLTAGE RATING (RESISTANCE)
L	COILCRAFT LPS4018-103ML	10 μΗ	3.9 mm x 3.9 mm x 1.7 mm	1 A $(R_{DC} = 0.2 \Omega)$
COUT	Murata GRM21BR71H105KA12L	1 μF	0805	50 V
CIN	Murata GRM188R71A225KE15D	2.2 μF	0603	10 V

#### 8.2.2.1 Inductor Selection

The LM3532 is designed to work with a 10-µH to 22-µH inductor. When selecting the inductor, ensure that the saturation rating is high enough to accommodate the applications peak inductor current. The inductance value must also be large enough so that the peak inductor current is kept below the LM3532's switch current limit. See *Maximum Output Power* for more details. Table 22 lists various inductors that can be used with the LM3532. The inductors with higher saturation currents are more suitable for applications with higher output currents or voltages (multiple strings). The smaller devices are geared toward single string applications with lower series LED counts.

**Table 22. Suggested Inductors** 

MANUFACTURER	PART NUMBER	VALUE	SIZE	CURRENT RATING	DC RESISTANCE
TDK	VLS252010T-100M	10 μH	2.5 mm × 2 mm × 1 mm	590 mA	0.712 Ω
TDK	VLS2012ET-100M	10 μH	2 mm × 2 mm × 1.2 mm	695 mA	0.47 Ω
TDK	VLF301512MT-100M	10 μΗ	3.0 mm × 2.5 mm × 1.2mm	690 mA	0.25 Ω
TDK	VLF4010ST-100MR80	10 μH	2.8 mm × 3 mm × 1 mm	800 mA	0.25 Ω
TDK	VLS252012T-100M	10 μH	2.5 mm × 2 mm × 1.2mm	810 mA	0.63 Ω
TDK	VLF3014ST-100MR82	10 μH	2.8 mm × 3 mm × 1.4mm	820 mA	0.25 Ω
TDK	VLF4014ST-100M1R0	10 μH	3.8 mm × 3.6 mm × 1.4 mm	1000 mA	0.22 Ω
Coilcraft	XPL2010-103ML	10 μH	1.9 mm × 2 mm × 1 mm	610 mA	0.56 Ω
Coilcraft	LPS3010-103ML	10 μH	2.95 mm × 2.95 mm × 0.9 mm	550 mA	0.54 Ω
Coilcraft	LPS4012-103ML	10 μΗ	3.9mm × 3.9mm × 1.1mm	1000 mA	0.35 Ω
Coilcraft	LPS4012-223ML	22 μΗ	3.9 mm × 3.9 mm × 1.1 mm	780 mA	0.6 Ω
Coilcraft	LPS4018-103ML	10 μΗ	3.9 mm × 3.9 mm × 1.7 mm	1100 mA	0.2 Ω
Coilcraft	LPS4018-223ML	22 μΗ	3.9 mm × 3.9 mm × 1.7 mm	700 mA	0.36 Ω



#### 8.2.2.2 Capacitor Selection

The LM3532's output capacitor has two functions: filtering of the boost converter's switching ripple, and to ensure feedback loop stability. As a filter, the output capacitor supplies the LED current during the boost converter's on time and absorbs the inductor's energy during the switch's off time. This causes a sag in the output voltage during the on time and a rise in the output voltage during the off time. Because of this, the output capacitor must be sized large enough to filter the inductor current ripple that could cause the output voltage ripple to become excessive. As a feedback loop component, the output capacitor must be at least 1µF and have low ESR; otherwise, the LM3532's boost converter can become unstable. This requires the use of ceramic output capacitors. Table 23 lists part numbers and voltage ratings for different output capacitors that can be used with the LM3532.

Table 23. Input/Output Capacitors

MANUFACTURER	PART NUMBER	VALUE	SIZE	RATING	DESCRIPTION
Murata	GRM21BR71H105KA12	1 μF	0805	50 V	C <sub>OUT</sub>
Murata	GRM188B31A225KE33	2.2 μF	0805	10 V	C <sub>IN</sub>
TDK	C1608X5R0J225	2.2 μF	0603	6.3 V	C <sub>IN</sub>

#### 8.2.2.3 Diode Selection

The diode connected between the SW and OUT pins must be a Schottky diode and have a reverse breakdown voltage high enough to handle the maximum output voltage in the application. Table 24 lists various diodes that can be used with the LM3532.

Table 24. Diodes

MANUFACTURER	PART NUMBER	VALUE	SIZE	RATING
Diodes Inc.	B0540WS	Schottky	SOD-323	40/500 V/mA
Diodes Inc.	SDM20U40	Schottky	SOD-523 (1.2 mm × 0.8 mm × 0.6 mm)	40/200 V/mA
On Semiconductor	NSR0340V2T1G	Schottky	SOD-523 (1.2 mm × 0.8 mm × 0.6 mm)	40/250 V/mA
On Semiconductor	NSR0240V2T1G	Schottky	SOD-523 (1.2 mm × 0.8 mm × 0.6 mm)	40/250 V/mA

#### 8.2.2.4 Maximum Output Power

The LM3532 device's maximum output power is governed by two factors: the peak current limit ( $I_{CL}$  = 880 mA minimum), and the maximum output voltage ( $V_{OVP}$  = 40 V minimum). When the application causes either of these limits to be reached it is possible that the proper current regulation and matching between LED current strings may not be met.

#### 8.2.2.4.1 Peak Current Limited

In the case of a peak current limited situation, when the peak of the inductor current hits the LM3532's current limit the NFET switch turns off for the remainder of the switching period. If this happens, each switching cycle the LM3532 begins to regulate the peak of the inductor current instead of the headroom across the current sinks. This can result in the dropout of the feedback-enabled current sinks and the current dropping below its programmed level.

The peak current in a boost converter is dependent on the value of the inductor, total LED current ( $I_{OUT}$ ), the output voltage ( $V_{OUT}$ ) (which is the highest voltage LED string + 0.4 V regulated headroom voltage), the input voltage  $V_{IN}$ , and the efficiency (output power/input power). Additionally, the peak current is different depending on whether the inductor current is continuous during the entire switching period (CCM) or discontinuous (DCM) where it goes to 0 before the switching period ends.

For CCM the peak inductor current is given by:

$$IPEAK = \frac{IOUT \times VOUT}{VIN \times efficiency} + \left[ \frac{VIN}{2 \times fsw \times L} \times \left( 1 - \frac{VIN \times efficiency}{VOUT} \right) \right]$$
(5)



For DCM the peak inductor current is given by:

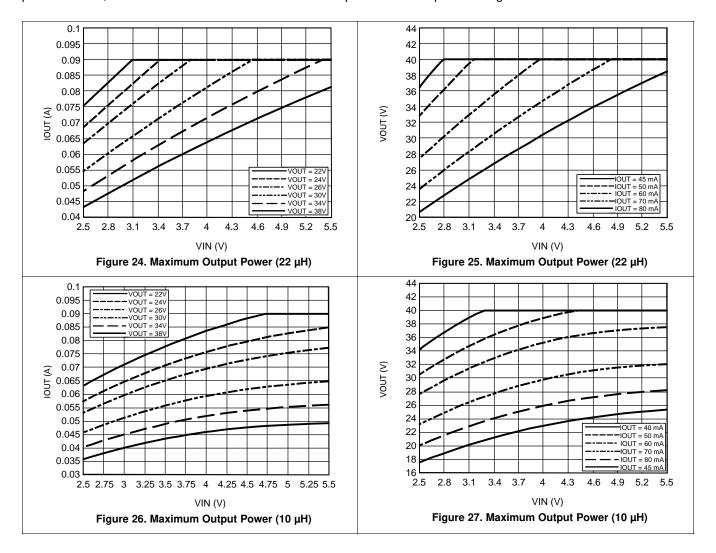
$$IPEAK = \sqrt{\frac{2 \times IOUT}{fsw \times L \times efficiency}} \times \left(VOUT - VIN \times efficiency\right)$$
(6)

To determine which mode the circuit is operating in (CCM or DCM) it is necessary to perform a calculation to test whether the inductor current ripple is less than the anticipated input current ( $I_{IN}$ ). If  $\Delta I_L$  is < then  $I_{IN}$  then the device is operating in DCM.

$$\frac{\text{IOUT x VOUT}}{\text{VIN x efficiency}} > \frac{\text{VIN}}{\text{fsw x L}} \times \left(1 - \frac{\text{VIN x efficiency}}{\text{VOUT}}\right)$$
(7)

Typically at currents high enough to reach the LM3532's peak current limit, the device is operating in CCM.

Figure 24, Figure 25, Figure 26, and Figure 27 show the output current and voltage derating for a  $10-\mu H$  and a  $22-\mu H$  inductor. These plots take Equation 5 and Equation 6 from above and plot  $V_{OUT}$  and  $I_{OUT}$  with varying  $V_{IN}$ , a constant peak current of 880 mA ( $I_{CL}$  min), and a constant efficiency of 85%. Using these curves can give a good design guideline on selecting the correct inductor for a given output power requirement. A 10  $\mu H$  is typically a smaller device with lower on resistance, but the peak currents are higher. A  $22-\mu H$  inductor provides for lower peak currents, but to match the DC resistance of a  $10-\mu H$  inductor requires a larger-sized device.





## 8.2.2.4.2 Output Voltage Limited

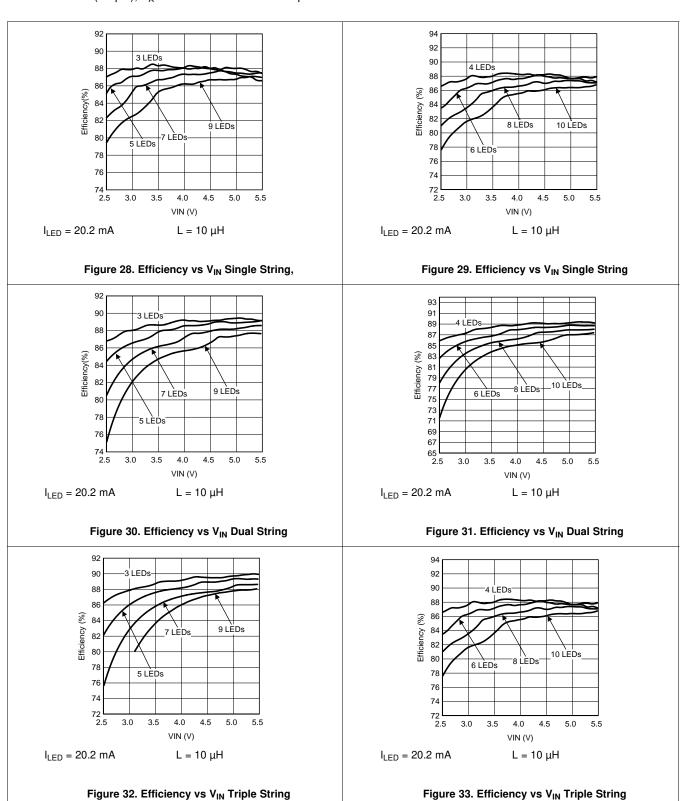
When the LM3532 output voltage (highest voltage LED string + 400-mV headroom voltage) reaches 40 V, the OVP threshold is hit, and the NFET turns off and remains off until the output voltage drops 1V below the OVP threshold. Once  $V_{OUT}$  falls below this hysteresis, the boost converter turns on again. In high output voltage situations the LM3532 begins to regulate the output voltage to the  $V_{OVP}$  level instead of the current sink headroom voltage. This can result in a loss of headroom voltage across the feedback enabled current sinks resulting in the LED current dropping below its programmed level.

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## 8.2.3 Application Curves

 $V_{IN}$  = 3.6 V, LEDs ( $V_F$  = 3.2 V at 20 mA,  $T_A$  = 25°C),  $C_{OUT}$  = 1  $\mu F$ ,  $C_{IN}$  = 2.2  $\mu F$ , L = Coilcraft LPS4018-103ML (10  $\mu H$  ) or LPS4018-223M (22  $\mu H$ ),  $T_A$  = 25°C unless otherwise specified.



 $V_{IN}$  = 3.6 V, LEDs ( $V_F$  = 3.2 V at 20 mA,  $T_A$  = 25°C),  $C_{OUT}$  = 1  $\mu F$ ,  $C_{IN}$  = 2.2  $\mu F$ , L = Coilcraft LPS4018-103ML (10  $\mu H$  ) or LPS4018-223M (22  $\mu H$ ),  $T_A$  = 25°C unless otherwise specified.

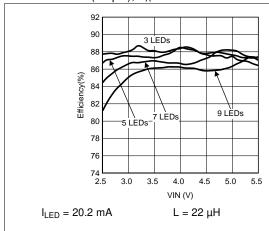
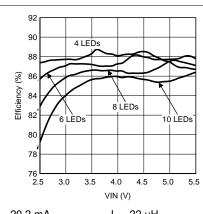


Figure 34. Efficiency vs V<sub>IN</sub> Single String



 $I_{LED} = 20.2 \text{ mA} \qquad \qquad L = 22 \ \mu H$ 

Figure 35. Efficiency vs V<sub>IN</sub> Single String

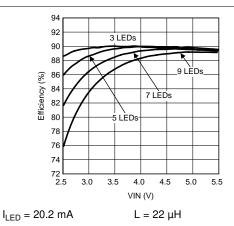


Figure 36. Efficiency vs V<sub>IN</sub> Dual String

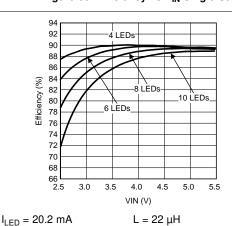


Figure 37. Efficiency vs V<sub>IN</sub> Dual String, lled = 20.2ma Per

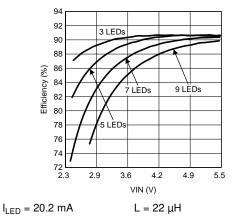


Figure 38. Efficiency vs V<sub>IN</sub> Triple String

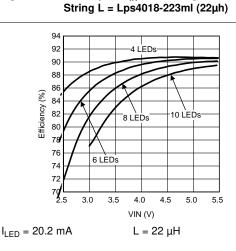


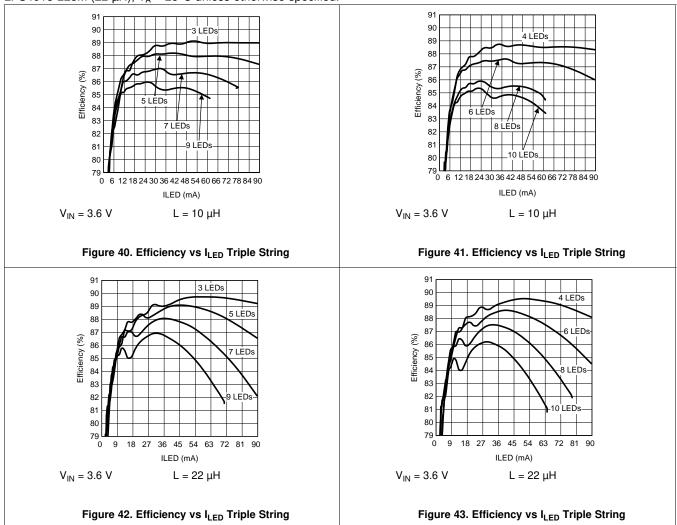
Figure 39. Efficiency vs V<sub>IN</sub> Triple String

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 $V_{IN}$  = 3.6 V, LEDs ( $V_F$  = 3.2 V at 20 mA,  $T_A$  = 25°C),  $C_{OUT}$  = 1  $\mu F$ ,  $C_{IN}$  = 2.2  $\mu F$ , L = Coilcraft LPS4018-103ML (10  $\mu H$  ) or LPS4018-223M (22  $\mu H$ ),  $T_A$  = 25°C unless otherwise specified.



## 9 Power Supply Recommendations

The LM3532 is designed to operate from an input supply range of 2.7 V to 5.5 V. This input supply should be well regulated and provide the peak current required by the LED configuration and inductor selected.

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## 10 Layout

## 10.1 Layout Guidelines

The LM3532 contains an inductive boost converter which sees a high switched voltage (up to 40 V) at the SW pin, and a step current (up to 1 A) through the Schottky diode and output capacitor each switching cycle. The high switching voltage can create interference into nearby nodes due to electric field coupling (I = CdV/dt). The large step current through the diode, and the output capacitor can cause a large voltage spike at the SW pin and the OVP pin due to parasitic inductance in the step current conducting path (V = LdI/dt). Board layout guidelines are geared towards minimizing this electric field coupling and conducted noise. Figure 44 highlights these two noise generating components.

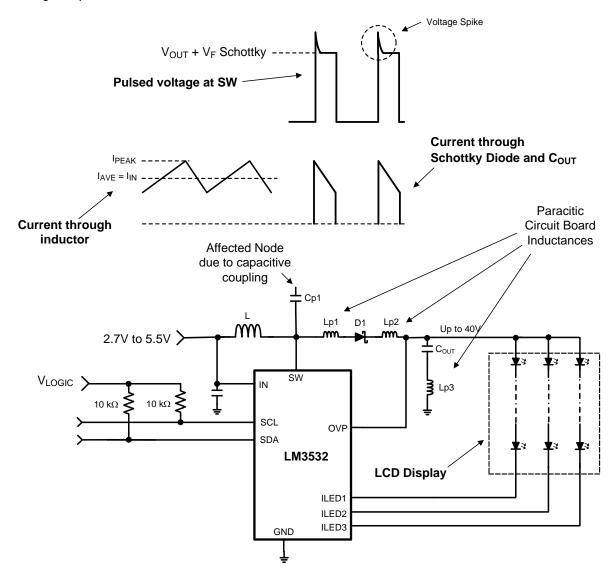


Figure 44. LM3532'S Boost Converter Showing Pulsed Voltage at SW (High Dv/Dt) and Current Through Schottky and C<sub>OUT</sub> (High Di/Dt)

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#### **Layout Guidelines (continued)**

The following lists the main (layout sensitive) areas of the LM3532 in order of decreasing importance:

## **Output Capacitor**

- Schottky Cathode to COUT+
- COUT- to GND

#### **Schottky Diode**

- · SW Pin to Schottky Anode
- Schottky Cathode to COUT+

#### Inductor

SW Node PCB capacitance to other traces

#### **Input Capacitor**

- CIN+ to IN pin
- CIN- to GND

#### 10.1.1 Output Capacitor Placement

The output capacitor is in the path of the inductor current discharge current. As a result,  $C_{OUT}$  sees a high current step from 0 to  $I_{PEAK}$  each time the switch turns off and the Schottky diode turns on. Typical turnoff/turnon times are around 5 ns. Any inductance along this series path from the cathode of the diode through  $C_{OUT}$  and back into the LM3532's GND pin contributes to voltage spikes ( $V_{SPIKE} = L_{PX} \times dI/dt$ ) at SW and OUT which can potentially over-voltage the SW pin, or feed through to GND. To avoid this,  $C_{OUT}$ + must be connected as close as possible to the Cathode of the Schottky diode and  $C_{OUT}$ - must be connected as close as possible to the LM3532's GND bump. The best placement for  $C_{OUT}$  is on the same layer as the LM3532 to avoid any vias that add extra series inductance (see *Layout Examples*).

#### 10.1.2 Schottky Diode Placement

The Schottky diode is in the path of the inductor current discharge. As a result the Schottky diode sees a high current step from 0 to  $I_{PEAK}$  each time the switch turns off and the diode turns on. Any inductance in series with the diode causes a voltage spike ( $V_{SPIKE} = L_{PX} \times dI/dt$ ) at SW and OUT which can potentially over-voltage the SW pin, or feed through to VOUT and through the output capacitor and into GND. Connecting the anode of the diode as close as possible to the SW pin and the cathode of the diode as close as possible to COUT+ reduces the inductance ( $L_{PX}$ ) and minimize these voltage spikes (see *Layout Examples*).

#### 10.1.3 Inductor Placement

The node where the inductor connects to the LM3532's SW bump has 2 issues. First, a large switched voltage (0 to  $V_{OUT} + V_{F\_SCHOTTKY}$ ) appears on this node every switching cycle. This switched voltage can be capacitively coupled into nearby nodes. Second, there is a relatively large current (input current) on the traces connecting the input supply to the inductor and connecting the inductor to the SW bump. Any resistance in this path can cause large voltage drops that negatively affect efficiency.

To reduce the capacitively coupled signal from SW into nearby traces, the SW bump to inductor connection must be minimized in area. This limits the PCB capacitance from SW to other traces. Additionally, other nodes need to be routed away from SW and not directly beneath. This is especially true for high impedance nodes that are more susceptible to capacitive coupling such as (SCL, SDA, HWEN, PWM, and possibly ASL1 and ALS2). A GND plane placed directly below SW helps isolate SW and dramatically reduce the capacitance from SW into nearby traces.

To limit the trace resistance of the VBATT to inductor connection and from the inductor to SW connection, use short, wide traces (see *Layout Examples*).



#### **Layout Guidelines (continued)**

#### 10.1.4 Input Capacitor Selection and Placement

The input bypass capacitor filters the inductor current ripple, and the internal MOSFET driver currents during turn on of the power switch.

The driver current requirement can be a few hundred milliamps with 5 ns rise and fall times. This appears as high dl/dt current pulses coming from the input capacitor each time the switch turns on. Close placement of the input capacitor to the IN pin and to the GND pin is critical because any series inductance between IN and  $C_{IN}^+$  or  $C_{IN}^-$  and GND can create voltage spikes that could appear on the  $V_{IN}$  supply line and in the GND plane.

Close placement of the input bypass capacitor at the input side of the inductor is also critical. The source impedance (inductance and resistance) from the input supply, along with the input capacitor of the LM3532, form a series RLC circuit. If the output resistance from the source ( $R_S$ ) is low enough the circuit is underdamped and has a resonant frequency (typically the case). Depending on the size of  $L_S$  the resonant frequency could occur below, close to, or above the LM3532's switching frequency. This can cause the supply current ripple to be:

- Approximately equal to the inductor current ripple when the resonant frequency occurs well above the LM3532's switching frequency;
- Greater then the inductor current ripple when the resonant frequency occurs near the switching frequency; or
- Less then the inductor current ripple when the resonant frequency occurs well below the switching frequency.

Figure 45 shows this series RLC circuit formed from the output impedance of the supply and the input capacitor. The circuit is re-drawn for the AC case where the  $V_{IN}$  supply is replaced with a short to GND and the LM3532 + Inductor is replaced with a current source ( $\Delta I_L$ ).

Equation 1 is the criteria for an underdamped response. Equation 2 is the resonant frequency. Equation 3 is the approximated supply current ripple as a function of  $L_S$ ,  $R_S$ , and  $C_{IN}$ .

As an example, consider a 3.6-V supply with 0.1  $\Omega$  of series resistance connected to  $C_{IN}$  through 50 nH of connecting traces. This results in an underdamped input filter circuit with a resonant frequency of 712 kHz. Because the switching frequency lies near to the resonant frequency of the input RLC network, the supply current is probably larger then the inductor current ripple. In this case, using equation 3 from Figure 45, the supply current ripple can be approximated as 1.68 times the inductor current ripple. Increasing the series inductance (L<sub>S</sub>) to 500 nH causes the resonant frequency to move to around 225 kHz and the supply current ripple to be approximately 0.25 times the inductor current ripple.



## **Layout Guidelines (continued)**

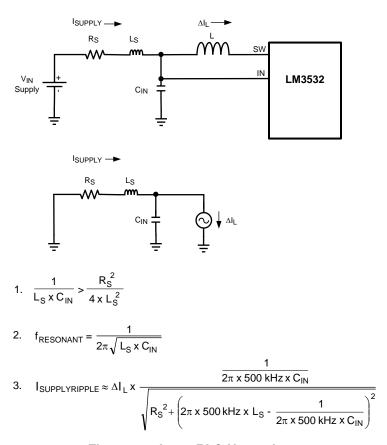


Figure 45. Input RLC Network

## 10.2 Layout Examples

Figure 46 and Figure 47 show example layouts which apply the required (proper) layout guidelines. These figures should be used as guides for laying out the LM3532's boost circuit.

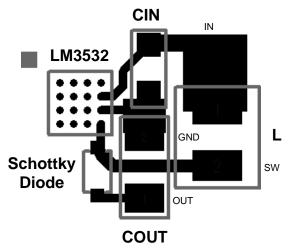


Figure 46. Layout Example 1

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# **Layout Examples (continued)**

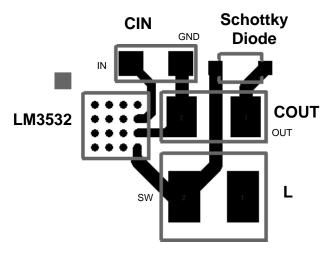


Figure 47. Layout Example 2



## 11 Device and Documentation Support

## 11.1 Device Support

## 11.1.1 Third-Party Products Disclaimer

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## 11.2 Documentation Support

### 11.2.1 Related Documentation

For related documentation see the following:

Application Note AN-1112: DSBGA Wafer Level Chip Scale Package (SNVA009).

## 11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.4 Trademarks

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#### 11.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 11.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM3532TME-40A/NOPB	ACTIVE	DSBGA	YFQ	16	250	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-40 to 125	D34	Samples
LM3532TMX-40A/NOPB	ACTIVE	DSBGA	YFQ	16	3000	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-40 to 125	D34	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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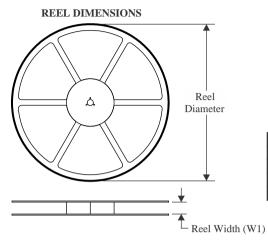


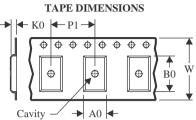
10-Dec-2020

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 31-Aug-2023

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

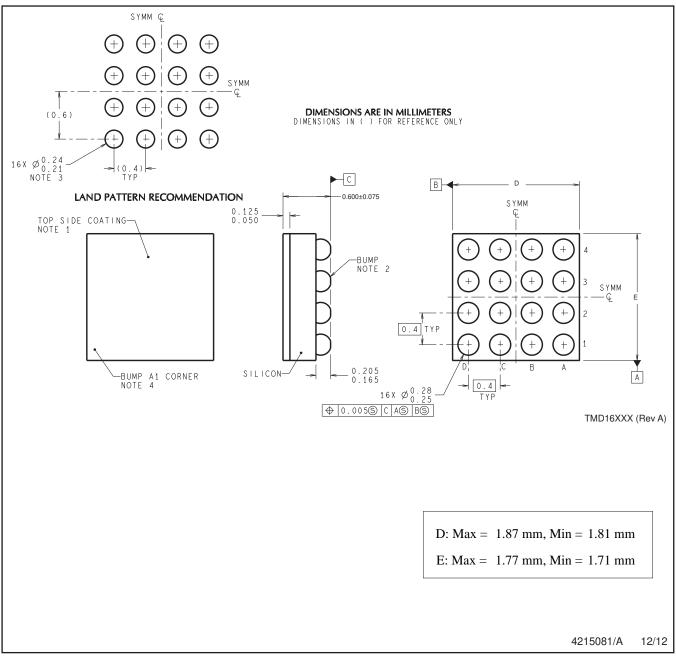
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM3532TME-40A/NOPB	DSBGA	YFQ	16	250	178.0	8.4	1.85	2.01	0.76	4.0	8.0	Q1
LM3532TMX-40A/NOPB	DSBGA	YFQ	16	3000	178.0	8.4	1.85	2.01	0.76	4.0	8.0	Q1

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## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM3532TME-40A/NOPB	DSBGA	YFQ	16	250	208.0	191.0	35.0
LM3532TMX-40A/NOPB	DSBGA	YFQ	16	3000	208.0	191.0	35.0



 $NOTES: \quad A. \ All \ linear \ dimensions \ are \ in \ millimeters. \ Dimensioning \ and \ tolerancing \ per \ ASME \ Y14.5M-1994.$ 

B. This drawing is subject to change without notice.

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